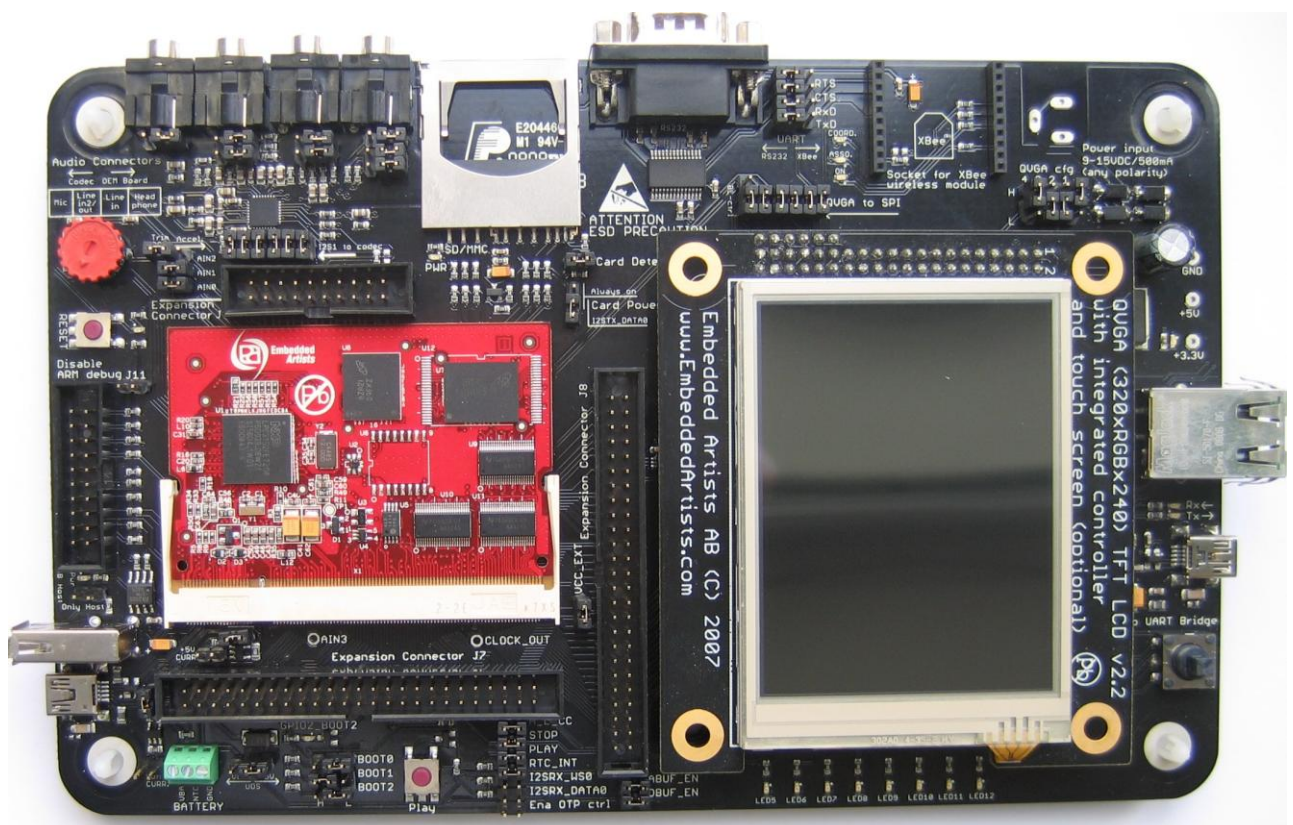


LPC3131/41 Developer's Kit - User's Guide

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LPC3131/41 Developer's Kit User's Guide



*Get Up-and-Running Quickly and
Start Developing Your Applications On Day 1!*

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1 Document Revision History

<i>Revision</i>	<i>Date</i>	<i>Description</i>
A	2009-03-09	First complete version. Add description about booting and correct language and spelling errors.
B	2009-04-11	Update description of MMC/SD card detect fix and codec handling.
C	2009-05-05	Update description for LPC31xx Base Board v2.0 (with Ethernet).
D	2009-06-18	Update with description for EWARM.
E	2009-09-09	Added information about LPC3141. Added information about NAND boot and LCD/Ethernet problem (<i>section 5.3.6</i>).
F	2009-11-27	Changed title of manual to 'Developer's Kit' manual. Updated OEM Board schematic to v1.2. Replaced earlier section 5.3.6 with new section about NAND boot and LCD/Ethernet problem (<i>section 4.7</i>).
G	2010-07-05	Added information in section 4.3 about things to note about the LPC31xx Base Board (UDA1380 I2C address, SD card detect logic, USB Host powering).
H	2010-11-15	Updated information about NAND boot problem.

2 Introduction

Thank you for buying Embedded Artists' *LPC3131/41 Developer's Kit* based on NXP's ARM926EJ-S LPC3131/41 microcontroller.

This document is a User's Guide that describes the *LPC3131/41 OEM Board* and the *LPC31xx Base Board* hardware design. It is the User's Manual for both the *LPC3131/41 Developer's Kit* as well as for just the *LPC3131/41 OEM Board*.

2.1 Features

Embedded Artists' *LPC3131/41 Developer's Kit* with NXP's ARM926EJ-S LPC3131/41 microcontroller lets you get up-and-running quickly. The small sized OEM board offers many unique features that ease your learning curve and speed up your program development. The board has also been designed for OEM applications with volume discount available. The features of the LPC3131/41 OEM board are:

- NXP's ARM926EJ-S LPC3131/41 microcontroller in BGA package, with 192 KByte internal RAM
- External data memory: 64 MB SDRAM (16-bit databus width)
- External FLASH memories: 256 MB (2Gbit) NAND FLASH and 4 MB (32Mbit) SPI-NOR FLASH
- 12.0000 MHz crystal for maximum execution speed and standard serial bit rates, including CAN and USB requirements
- 256 Kbit I2C E2PROM for storing non-volatile parameters
- Buffered 16-bit data bus for external expansion
- 200 pos expansion connector (SODIMM-200 format, 0.6mm pitch)
 - All LPC3131/41 pins available (except dedicated pins for on-board memories)
- +5V only powering
- Onboard reset generation
- Compact SODIMM size: 66 x 48 mm
 - Six layer PCB design for best noise immunity

There is an accompanying *LPC31xx Base Board* that can be used for initial prototyping work. The features of the board are:

- Connectors
 - 200 pos, 0.6mm pitch SODIMM connector for LPC3131/41 OEM Board
 - RJ45 Ethernet connector (available on base board from v2.0)
 - Expansion connector to 3.2 inch QVGA TFT color LCD with touch panel
 - Three expansion connectors with all SODIMM signals
 - MMC/SD interface and connector
 - USB OTG or Host connectors
 - Four 3.5mm audio connectors (mic in, line in, line out, headphone out)
 - JTAG connector

- 2.1mm power input
- Power
 - Power supply, either via USB or external 9-15V DC (*LPC3131/41 OEM Board* is powered with +5V)
 - Current monitors on input voltages
- Other
 - 100/10Mbps Ethernet interface base on DM9000A chip (available on base board from v2.0)
 - UDA1380 I2S codec with mic in, line in, line out, and headphone out
 - 5-key joystick (via I2C)
 - 3-axis accelerometer
 - 8 LEDs (via I2C)
 - Trimpot analog input
 - USB-to-serial bridge on UART (FT232R)
 - RS232 alternative interface on UART
 - XBee™ RF-module alternative interface on UART (note that XBee module is not included in bundle)
 - Reset push-button and LED
 - 205x135 mm in size

2.2 ESD and Handling Precaution

Please note that the *LPC3131/41 OEM Board* and *LPC31xx Base Board* come without any case/box and all components are exposed for finger touches – and therefore extra attention must be paid to ESD (Electro-Static Discharge) precaution.

Make it a habit to always first touch the metal surface of one of the USB or SC/MMC connectors for a few seconds with both hands before touching any other parts of the boards. That way, you will have the same electrical potential as the board and therefore minimize the risk for ESD.

Never touch directly on the *LPC3131/41 OEM Board* and in general as little as possible on the *LPC31xx Base Board*. The keys on the *LPC31xx Base Board* have grounded shields to minimize the effect of ESD.

Note that Embedded Artists does not replace boards that have been damaged by ESD.

In case you have also connected the *QVGA Display Module* to the *LPC31xx Base Board*, do not exercise excessive pressure on the LCD glass area. That will damage the display. Also, do not apply pressure on the two flex cables connecting the LCD. These are relatively sensitive and can be damaged if too much pressure is applied to them.

Note that Embedded Artists do not replace QVGA Display Modules where the LCD has been improperly handled.

2.3 LPC3131/41 Core Voltage Precaution

The core voltage for the LPC3131/41 can be dynamically changed, via I2C commands sent to the LTC3447 voltage converter. The voltage can be set to up to 2V. Note that this is above

the limits of the core voltage. See LPC3131/41 datasheet for details (the maximum core voltage is 1.30V).

Note that Embedded Artists do not replace LPC3131/41 OEM boards where the core voltage ($V_{DD(CORE)}$) has been raised above 1.30 Volt. It is the user's responsibility not to exceed the voltage specification found in the datasheet.

On version 1.1 boards, two zero ohm resistors/jumpers must be soldered to the *LPC3131/41 OEM Board* in order to connect the I2C communication channel of the LTC3447 to I2C channel#1. See the schematic for details.

2.4 Other Products from Embedded Artists

Embedded Artists have a broad range of LPC1xxx/LPC2xxx/LPC3xxx based boards that are very low cost and developed for prototyping / development as well as for OEM applications. Modifications for OEM applications can be done easily, even for modest production volumes. Contact Embedded Artists for further information about design and production services.

2.4.1 Design and Production Services

Embedded Artists provide design services for custom designs, either completely new or modification to existing boards. Specific peripherals and I/O can be added easily to different designs, for example, communication interfaces, specific analog or digital I/O, and power supplies. Embedded Artists has a broad, and long, experience in designing industrial electronics in general and with NXP's LPC2xxx microcontroller family in specific. Our competence also includes wireless and wired communication for embedded systems. For example IEEE802.11b/g (WLAN), Bluetooth™, ZigBee™, ISM RF, Ethernet, CAN, RS485, and Fieldbuses.

2.4.2 OEM / Education / QuickStart Boards and Kits

Visit Embedded Artists' home page, www.EmbeddedArtists.com, for information about other *OEM / Education / QuickStart* boards / kits or contact your local distributor.

3 LPC3131/41 OEM Board Design

This chapter contains detailed information about the electrical and mechanical design of the *LPC3131/41 OEM Board*. Note that it is version 1.2 of the board that is presented. Differences from version 1.1 and 1.0 are small and can be seen in the schematic (first page).

3.1 LPC3131/41 OEM Board Schematics, v1.2

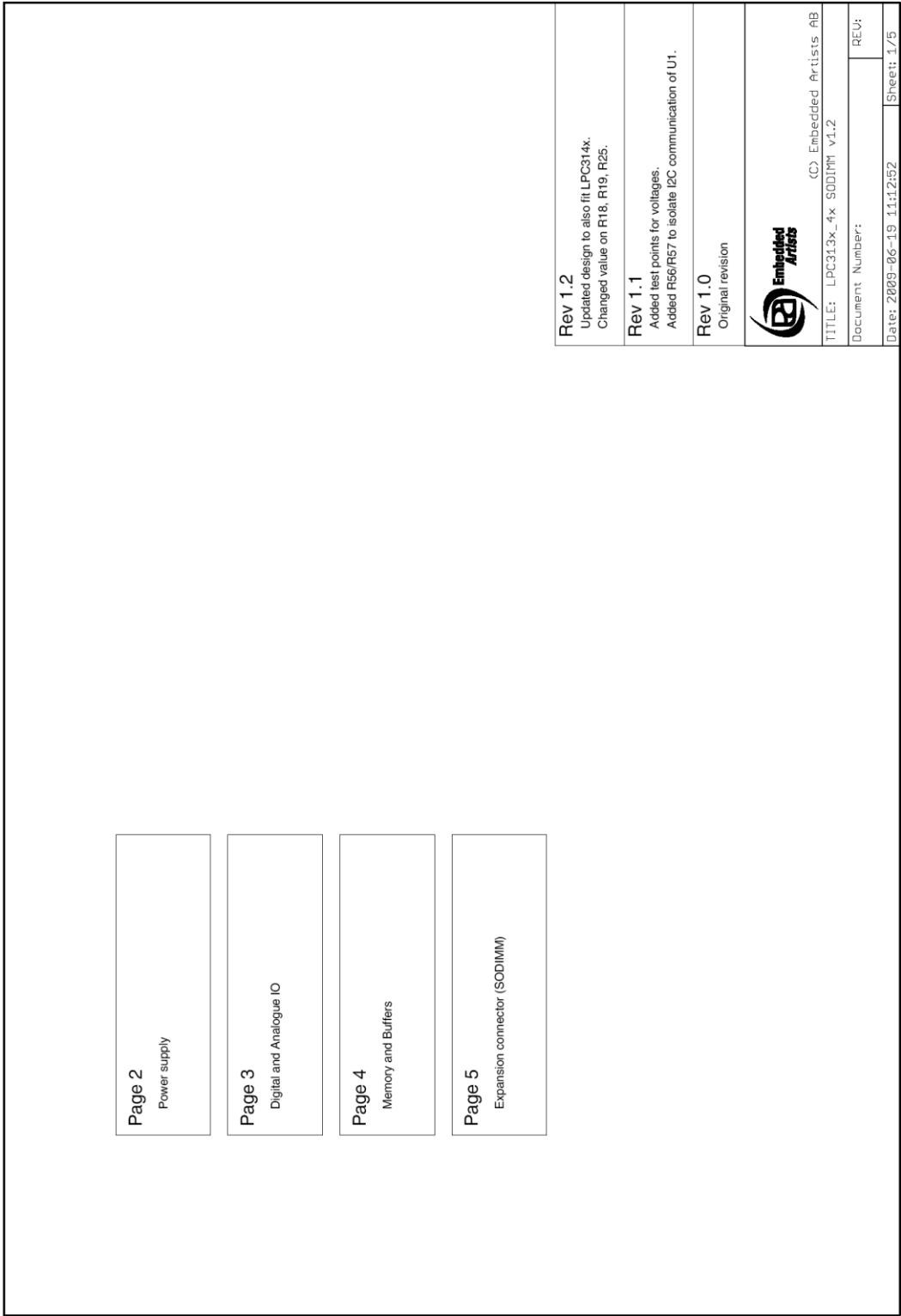


Figure 1 – LPC3131/41 OEM Board Schematic, v1.2, page 1

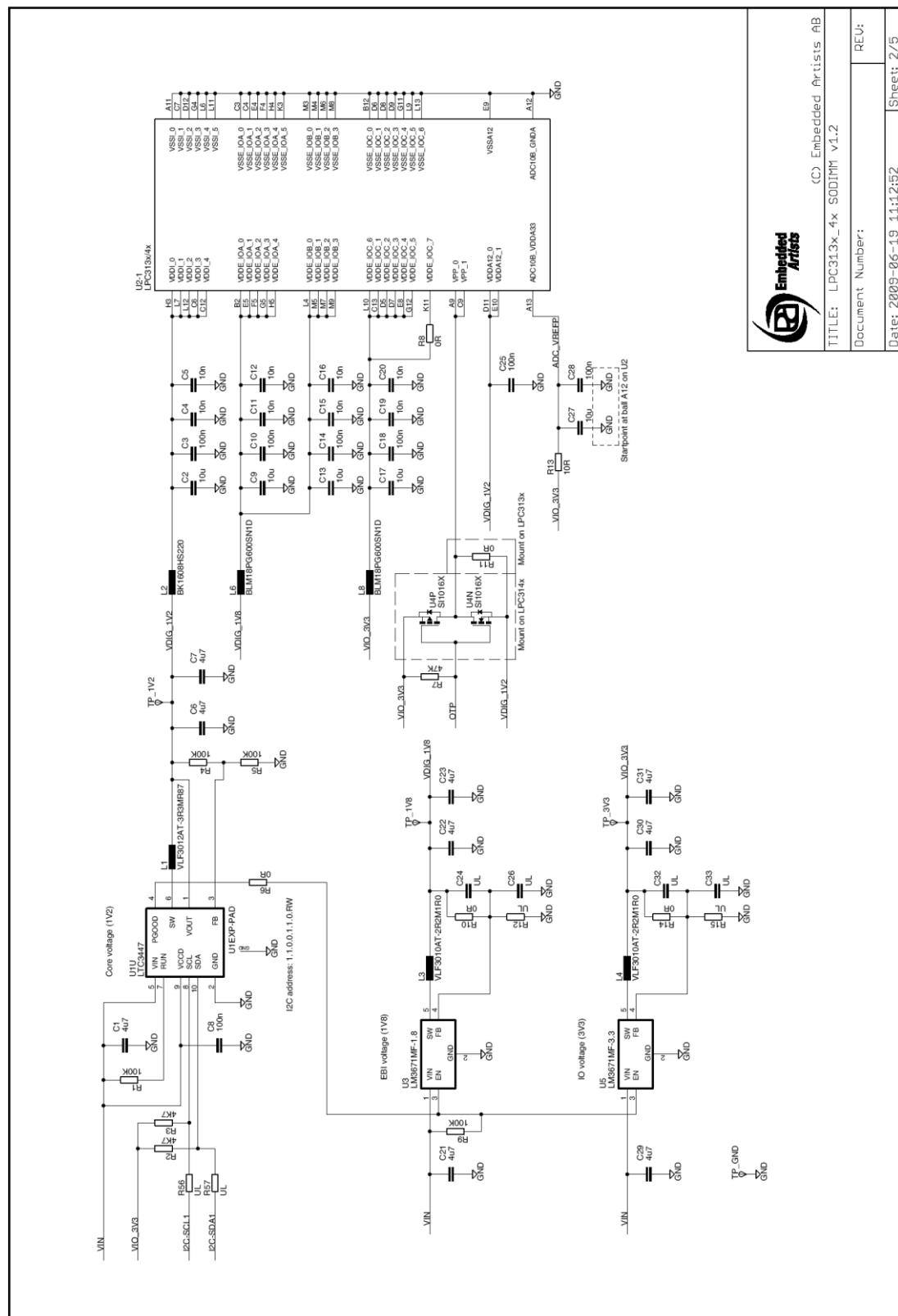


Figure 2 – LPC3131/41 OEM Board Schematic, v1.2, page 2



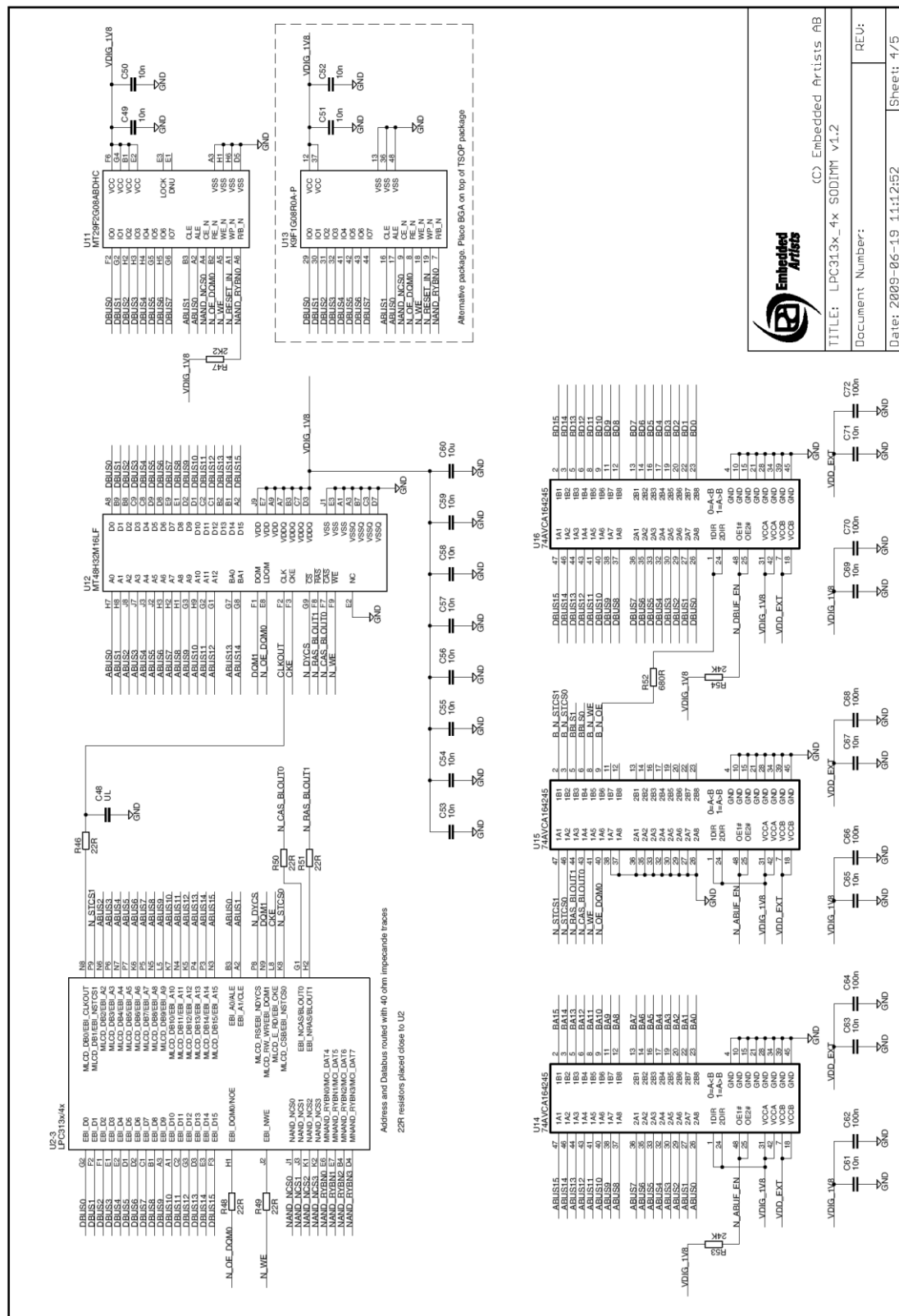
(C) Embedded Artists AB

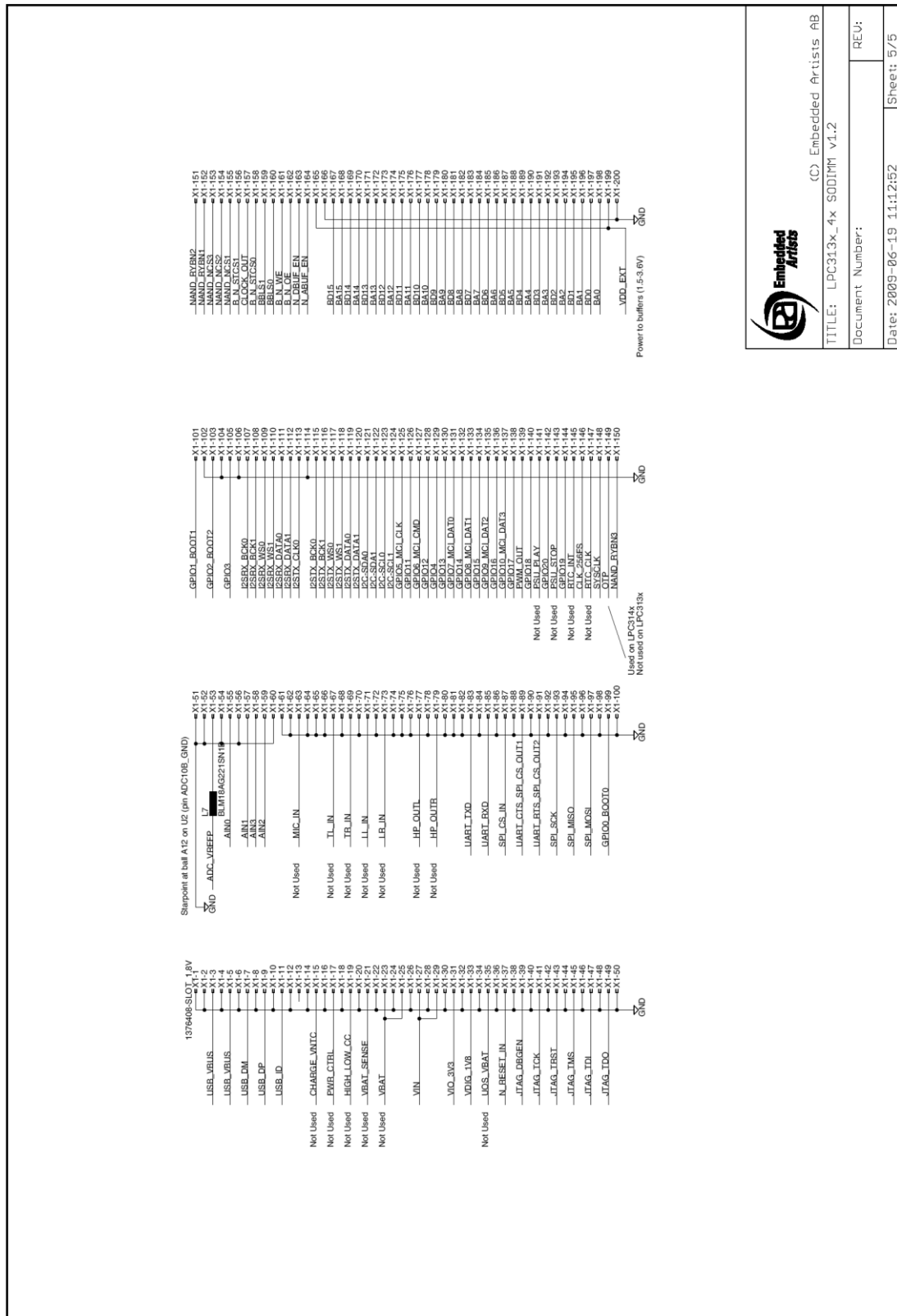
TITLE: LPC313x_4x SODIMM v1.2

Document Number: REV:

Date: 2009-06-19 11:12:52 Sheet: 2/5







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TITLE: LPC3131x_4x SODIMM v1.2

Document Number: REV:

Date: 2009-06-19 11:12:52 Sheet: 5/5

The following subsections describe in more detail each part of the design.

3.1.1 Page 2: Powering

Page 2 of the schematic contains the power supplies of the *LPC3131/41 OEM Board*.

3.1.1.1 1.8V and 3.3V Voltages

The LPC3131/41 requires three voltages; 1.2V for the core, 1.8V for the memory interface and 3.3V for the rest of the i/o interfaces. The 1.8V and 3.3V voltages are fixed and generated by two LM3671MF step-down switching regulators from National Semiconductor. These regulators are capable of generating 600mA, which by far exceed the needed current by the LPC3131/41 and other components on the *LPC3131/41 OEM Board*.

3.1.1.2 1.2V Adjustable Core Voltage

The core 1.2V voltage is adjustable and is generated by the step down switching regulator LTC3447 from Linear Technologies. This regulator is capable of generating 600mA, which also by far exceed the needed current by the LPC3131/41. The adjustment is done via an I2C channel, I2C1 in the LPC3131/41 case. The core voltage can be adjusted as a power save feature. By lowering the voltage, the total power consumption can be lowered but the clock frequency of the core must then also be lowered. This is a trade-off that is important for hand held equipment. **Note that it is the user's responsibility not to program the LTC3447 to generate too high core voltage, which is possible.** The LTC3447 can generate voltages up to 2V, which by far exceed the limits for the LPC3131/41. To minimize the risk of accidentally setting the voltage the I2C channel is disconnected via R56/R57 (which are 0 ohm resistors/jumpers that are not mounted). R56/R57 is the only thing that differs between v1.0 and v1.1 of the board. On v1.0, the I2C1 of the LPC3131/41 is always connected to the LTC3447.

See the LPC3131/41 datasheet for exact details about ranges, but it is in the region of 1.1-1.3V. Also see the LTC3447 datasheet for details about how to adjust the voltage (it is a write-only register). The I2C address for the LTC3447 is indicated in the schematic.

3.1.1.3 Input Voltage

The input voltage to the *LPC3131/41 OEM Board* is given by the requirements of the LM3671 and LTC3447. A recommended input voltage range is 3.4 – 5.5V. The input supply must be stable but there are no special needs for bulk capacitors close to the power pins on the expansion connectors. The needed capacitors are placed close to the step down switching regulators on the *LPC3131/41 OEM Board*.

3.1.1.4 OTP VPP Voltage

The VPP power to the LPC3131 is fixed to 1.2V. The LPC3141 has on-chip OTP (One-Time Programmable) fuses that can be programmed. 3.3V must be applied to VPP during programming. The OTP voltage switch (U4) is mounted on *LPC3141 OEM Boards*, but not on *LPC3131 OEM Boards*.

3.1.2 Page 3: LPC3131/41 CPU

Page 3 of the schematic contains the core part of the design, which of course is the LPC3131/41 microcontroller. It is an ARM926EJ-S cpu core with a lot of different peripheral units and on-chip memory (192 KByte SRAM).

3.1.2.1 12MHz Crystal and PLLs

The microcontroller crystal frequency is 12.0000 MHz. This frequency is the recommended from NXP. There is dual on-chip PLLs on the LPC3131/41 in order to generate different needed frequencies for the chip. **Note that the clocking structure is very different from the LPC2xxx family. It is a more complex structure but also much more versatile and flexible.**

There is no shortcut but to read the LPC3131/41 User's Manual in detail and understand the options and settings.

The main thing differing between the LPC3131 and the LPC3141 is the maximum core frequency for the processor. See datasheet for details.

3.1.2.2 Booting

The LPC3131/41 start executing from an on-chip ROM, containing the bootloader. Note that the LPC3131/41 does not contain any on-chip FLASH memory. Program code must be loaded from an external source into the on-chip SRAM.

There are multiple boot options, as indicated in the schematic. The default is set to UART mode booting. Normally the default boot option can be controlled/changed from the *LPC31xx Base Board*, but the default resistors can also be changed for special orders of the board. The *LPC3131/41 OEM Board* contains both SPI NOR flash and NAND flash in order to support stand alone booting.

Section 4.7 contain important information if NAND boot is used.

3.1.2.3 JTAG interface

The JTAG interface is a standard ARM-compatible JTAG interface. There is a special feature on the LPC3131/41 that can bypass the ARM core scan chain (i.e. the debug access), by pulling JTAGSEL low. In that case, the JTAG interface is used for boundary scan access. The multiplexer (U17) selects the different scan chain outputs depending on the JTAGSEL signal. Normally this has no affect on the operation since the input signal JTAG_DBGEN (connected to JTAGSEL) is held high.

3.1.2.4 SPI NOR FLASH

There is a 32Mbit (4 MByte) NOR flash connected to the SPI bus. There is an option to mount one of two different manufacturers; either S25FL032 from Spansion or AT45DB321 from Atmel. Embedded Artists can choose to mount any one of these chips (or similar) on the board and it depends on component availability at the time of production. Both are compatible for the relevant commands. In case special commands are used, it is possible to read out chip id and determine type.

3.1.2.5 Reset Generation

The reset generation is handled by a standard voltage supervisor chip, CAT811R from Catalyst Semiconductor. The reset signal will be held active (i.e., low) until the supply voltages, +3.3V, is within margins (above 2.63V). The reset duration is typically 200 mS (consult the CAT811R datasheet for exact details). The output reset signal is push/pull output that is converted to an open-collector / open-drain output via the 74LVC1G125 buffer. An external reset source can pull the reset signal low (with an open-collector/open-drain output).

3.1.2.6 I2C E2PROM

There is a 256 kbit E²PROM accessible via the I²C interface. The LPC3131/41 has two on-chip I²C communication channels. Channel #0 is used for communicating with the E²PROM. More peripheral units are easily connected to the two-wire I²C bus, just as long as the addresses do not collide. The address of the 256kbit E²PROM is 0xA0, which is also indicated in the schematic.

There are 1.5 kohm pull-up resistors (pull-ups are always needed on I²C busses) included on the board on I2C channel #0.

3.1.2.7 USB Interface

There is a high-speed USB 2.0 (OTG, Host, Device) interface with on-chip PHY on the LPC3131/41. Note that special care must be taken for layout of the USB signals. This also applies for the external connector, connected to the expansion interface of the *LPC3131/41 OEM Board*.

3.1.2.8 Analog Inputs

The LPC3131/41 contains a 10-bit ADC (Analog to Digital Converter). The positive reference voltage is ADC_VREFP (found on page 2 of the schematic). It is a filtered version of the 3.3V voltage. The voltage ADC_VREFP is available on the expansion connector. There is also an associated analog ground reference available on the expansion connector (connected to pin ADC10B_GND on the LPC3131/41).

3.1.3 Page 4: External Memories

Page 4 of the schematic contains the external memory interface and the external memories. There are two memory components connected to the external 16-bit memory bus interface. Note that the LCD interface and external memory bus interface are multiplexed over the same pins. It is the memory bus interface that is used in the *LPC3131/41 OEM Board*. The LCD interface cannot be used and shall not be enabled in the cpu.

Also note that three different types of memories share the same bus interface:

- Dynamic memories (SDRAM)
Using signals RAS/CAS/DQM0/DQM1/ CLOCKOUT/CKE, etc.
- Static memories or general peripherals
Using signals OE/WE/BLOUT0/BLOUT1, etc.
- NAND Flash memories
Using signals CLE/ALE, etc.

Many of the signals are multiplexed on the same pins. The memory interface operates at 1.8V level, which minimizes power consumption.

3.1.3.1 Memory Layout

The external memory controller on the LPC3131/41 defines a number of memory regions, as listed below:

- External SDRAM bank 0 (0x3000 0000 – 0x33FF FFFF)
16-bit databus width and 64MByte in size.
- External SRAM bank 0 (0x2000 0000 – 0x2000 FFFF / 0x2001 FFFF)
128 kByte in size for 16-bit databus width and 64 kByte in size for 8-bit databus.
- External SRAM bank 1 (0x2002 0000 – 0x2002 FFFF / 0x2003 FFFF)
128 kByte in size for 16-bit databus width and 64 kByte in size for 8-bit databus.
- NAND band 0-3 (accessible via NAND flash controller, not directly via memory address)

The *LPC3131/41 OEM Board* uses the external SDRAM bank 0 as well as NAND bank 0. It is mainly the two external SRAM banks that are available for the off-board external memory interface of the *LPC3131/41 OEM Board*. Chip select signals N_STCS0 and N_STCS1 are free for external use via the buffered memory interface. Both the address and the data busses are buffered.

3.1.3.2 SDRAM

A 512 MBit (64 MByte) Mobile SDRAM is used, MT48H32M16LF from Micron. The chip is powered by 1.8V and is organized as 32Mbitx16, i.e. it has 16-bit databus width. The chip occupies the only available memory bank for dynamic RAM at address range 0x3000 0000 – 0x33FF FFFF.

3.1.3.3 NAND Flash

A 2 Gbit (256) NAND flash is used, MT29F2G08ABDHC from Micron. The chip is powered by 1.8V and has 8-bit databus width. The NAND flash builds on a single-level cell (SLC) technology and has a page size of 2112 bytes (2,048 + 64 bytes). The chip is connected to NAND bank 0. Note that the chip is not directly accessible via the memory bus. Instead, all accesses must be done via the on-chip NAND flash controller of the LPC3131/41. Embedded Artists can choose to mount a different brand of NAND flash dependent on component availability at the time of production. The application program should always read out the NAND flash chip id and determine type and features.

3.1.3.4 Buffers to External Interface

The LPC3131/41 memory interface is available on the expansion connector. The data bus width is 16-bits on the external interface. The relevant signals are buffered. The buffers are disabled by default unless enabled by external signals.

By pulling signal N_ABUF_EN low, the two buffers for address and control signals are enabled and act as outputs (from the *LPC3131/41 OEM Board*).

The data bus buffer is controlled by the signal N_DBUF_EN. By pulling this signal low, the data bus buffer is enabled. The buffered version of the LPC3131/41 signal OE controls the direction of the data bus buffer. During read operations the buffer acts as an input and during write operations it acts as an output.

Note that N_DBUF_EN must not be pulled low constantly. In that case the buffer will collide with the board's internal data bus. N_DBUF_EN must only be pulled low when an external memory/IO device is accessed. If only one of the static chip selects is used externally, just connect that signal to N_DBUF_EN. If more than one chip select signal is used, (logically) AND all chip select signal together before driving the N_DBUF_EN signal, in this case, just AND the two signals B_N_STCS0 and B_N_STCS1.

There is an additional important note when booting from NAND flash, read section 4.7 for details about the N_DBUF_EN signal.

If the external memory interface is not used, leave ABUS_EN and DBUS_EN unconnected.

The buffers are dual voltage buffers and act as level translators between the internal 1.8V signal levels and the external levels. Connect the external bus voltage to VDD_EXT. See the datasheet of 74AVCA164245 for exact details about voltage range. Normally 3.3V powering is used.

3.1.4 Page 5: Expansion Connector

The *LPC3131/41 OEM Board* integrates the core part of a typical LPC3131/41 board design with a reasonable large amount of external memories. All relevant signals of LPC3131/41 are available on the 200 pos, 0.6mm pitch expansion connector (SODIMM-200 format). See next section for a detailed list of available pins.

3.2 Usage of CPU Pins

Almost all pins of the LPC3131/41 are directly available on the expansion connectors. Only in a few cases pins are used for dedicated functionality like (dynamic) memory control

signals and chip select signals. Such pins are not available on the expansion connector. The table below lists all pins and their possible restrictions.

<i>Pin</i>	<i>Available on expansion connector</i>
USB_VBUS USB_DM USB_DP USB_ID	Yes
I2C_SDA0 I2C_SCL0	Yes, but I2C E2PROM connected to these pins.
I2C_SDA1 I2C_SCL1	Yes, but LTC3447 is connected to these pins on v1.0 boards. Can be connected on v1.1 boards.
SPI_CS_OUT0	No, signal used for chip select of SPI NOR flash (U7 or U10).
SPI_SCK SPI_MISO SPI_MOSI SPI_CS_IN	Yes, but note that SPI NOR flash is connected to SPI_SCK, SPI_MISO, SPI_MOSI.
UART_RXD UART_TXD UART_CTS/SPI_CS_OUT1 UART_RTS/SPI_CS_OUT2	Yes
I2SRX_DATA0 I2SRX_WS0 I2SRX_BCK0 I2STX_DATA0 I2STX_WS0 I2STX_BCK0	Yes
I2SRX_DATA1 I2SRX_WS1 I2SRX_BCK1 I2STX_DATA1 I2STX_WS1 I2STX_BCK1	Yes
GPIO0 GPIO1 GPIO2	Yes, but pull-ups/pull-downs are used to set default boot mode to booting from the UART.
GPIO3-GPIO20	Yes
PWM_DATA	Yes
ADC10B_GPA0- ADC10B_GPA3	Yes
CLK_256FS_O	Yes

CLOCK_OUT SYSCLK_O	
EBI_D0-EBI_D15	Yes, but only available via the data bus buffer
MLCD_A0/ALE MLCD_A1/CLK MLCD_DB2/EBI_A2 MLCD_DB3/EBI_A3 MLCD_DB4/EBI_A4 MLCD_DB5/EBI_A5 MLCD_DB6/EBI_A6 MLCD_DB7/EBI_A7 MLCD_DB8/EBI_A8 MLCD_DB9/EBI_A9 MLCD_DB10/EBI_A10 MLCD_DB11/EBI_A11 MLCD_DB12/EBI_A12 MLCD_DB13/EBI_A13 MLCD_DB14/EBI_A14 MLCD_DB15/EBI_A15	Yes, but only available via the address bus buffer
EBI_DQM0/NOE EBI_NWE EBI_NCAS/BLOUT0 EBI_NRAS/BLOUT1 MLCD_CSB/EBI_NSTCS0 MLCD_DB1/EBI_NSTCS1	Yes, but only available via the buffer
NAND_NCS0 MNAND_RYBN0/MCI_DATA4	No, used for internal NAND flash memory.
NAND_NCS1 NAND_NCS2 NAND_NCS3 MNAND_RYBN1/MCI_DATA5 MNAND_RYBN2/MCI_DATA6 MNAND_RYBN3/MCI_DATA7	Yes
MLCD_DB0/EBI_CLKOUT MLCD_RS/EBI_NDYCS MLCD_RW_WR/EBI_DQM1 MLCD_E_RD/EBI_CKE	No, used for internal SDRAM.
ADC_REFP ADC_REFN	Yes. Note that VDDA is connected to +3.3V power supply
FFAST_IN FFAST_OUT	No, directly connected to on-board crystals
JTAG signals	Yes, except for BUF_TRTS_N, BUF_TCK, BUF_TMS
RESET_IN	Yes

The *LPC31xx Base Board* illustrates how to typically connect external interfaces (like USB, external memory devices, etc) to the *LPC3131/41 OEM Board*. Study this schematic (also found in this document) for details.

3.3 LPC3131/41 OEM Board Mechanical Dimensions and Connector

Figure 6 below contains a drawing of the board that includes mechanical measures. See SODIMM-200 standard for exact measures. 1.8V keying is used (SODIMM-200 boards are either 1.8V or 2.5V keyed).

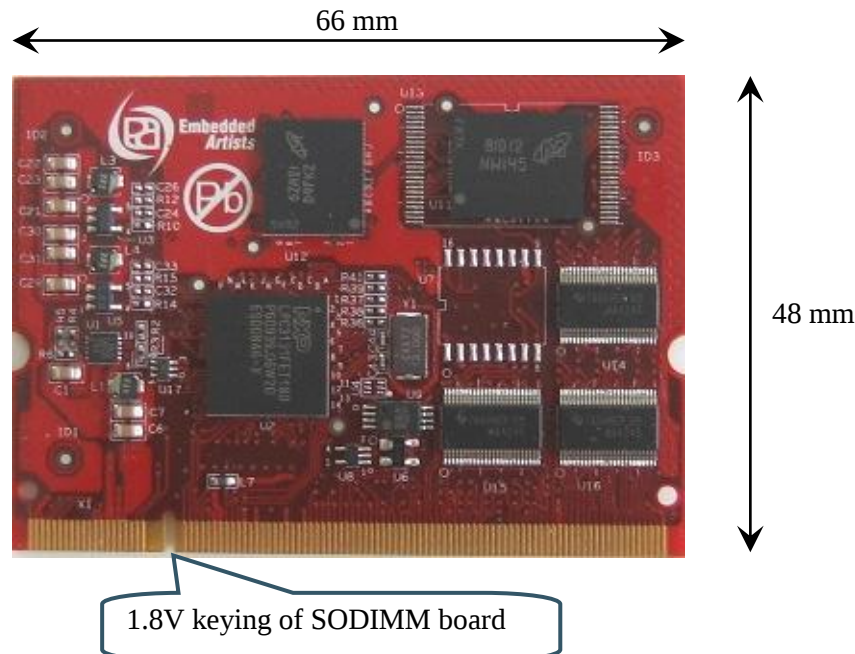


Figure 6 – LPC3131/41 OEM Board Mechanical Dimensions

The SODIMM-200 format is a standard and there exist many connectors that are suitable from many different manufactures. The many sources also keep the connector cost very low. Note that the connector should be 1.8V keyed.

One suitable connector is 0-1473005-4 from Tyco/AMP. Basically any SODIMM, DDR2, 200pos, 1.8V, right-angled connector will do.

3.4 Things to note about the LPC3131/41 OEM Board

3.4.1 NAND FLASH Bad Block

The NAND Flash is the MT29F2G08ABDHC from Micron and contains 2 GBit capacity. The chip may include invalid blocks when shipped from factory. A maximum of 40 invalid blocks may exist initially, i.e., 2008-2048 valid blocks. Additional invalid blocks may develop while being used. Invalid blocks are defined as blocks that contain one or more bad bits. Do not erase or program factory-marked bad blocks. More information about appropriate management of invalid blocks can be found in technical notes and datasheet from Micron.

3.4.2 Brand of Memory Chips

Note that there is no guarantee for a certain brand or version of memory chips; SPI-NOR flash, parallel NAND flash and SDRAM. The lifetime of memory chips is limited and availability can also be limited from time to time. Embedded Artists make every effort to mount the original design chip on the board. In case that is impossible a compatible chip will instead be mounted without any prior notice. There can be small programming differences

between mounted brands. The application program shall always read the chip id of flash devices to make certain which chip is actually mounted on the board.

The support page contains datasheets to the different memory devices and information about mounted devices on different board versions.

4 LPC31xx Base Board Design

This chapter contains detailed information about the electrical and mechanical design of the *LPC31xx Base Board*, version 2.0. The difference between v1.1 and v2.0 is that a 100/10Mbps Ethernet interface was added in v2.0. This new functionality is found on page 8 of the schematic. The differences between version 1.0 and v1.1 are very small and can be seen on revision comments on the first page of the schematic.

4.1 LPC31xx Base Board Schematics, v2.0

Page 2 SODIMM connector interface, Expansion connectors, Current monitors Page 3 JTAG interface, Memory card interface, USB interface, reset key&LED, Optional connections Page 4 I2C: LEDs and joystick, Boot mode control, Accelerometer and analog input Page 5 UART: USB-to-serial interface, RS232 interface, and XBee interface Page 6 QVGA display module interface Page 7 UDA1380 codec interface Page 8 100/10Mbps Ethernet interface		Rev 2.0 Added R114, R115 and C81. Changed J14 to 2x7 pin list. Added OTP control jumper. Added 100/10Mbps Ethernet interface (all of page 8). Rev 1.1 Change RS232 DSUB9 to Male pinout Corrected USB TX/RX LED mixup on page 5. Added R102/R103/R104/R105. Rev 1.0 Original revision  (C) Embedded Artists AB TITLE: LPC31xx Base Board v2.0 Document Number: REU: Date: 2009-04-10 23:59:48 Sheet: 1/8
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Default jumper settings are indicated in the schematic.
However, always check jumper positions on actual boards
since there is no guarantee that all jumpers are in default place.

Figure 7 – LPC31xx Base Board Schematic, v2.0, page 1



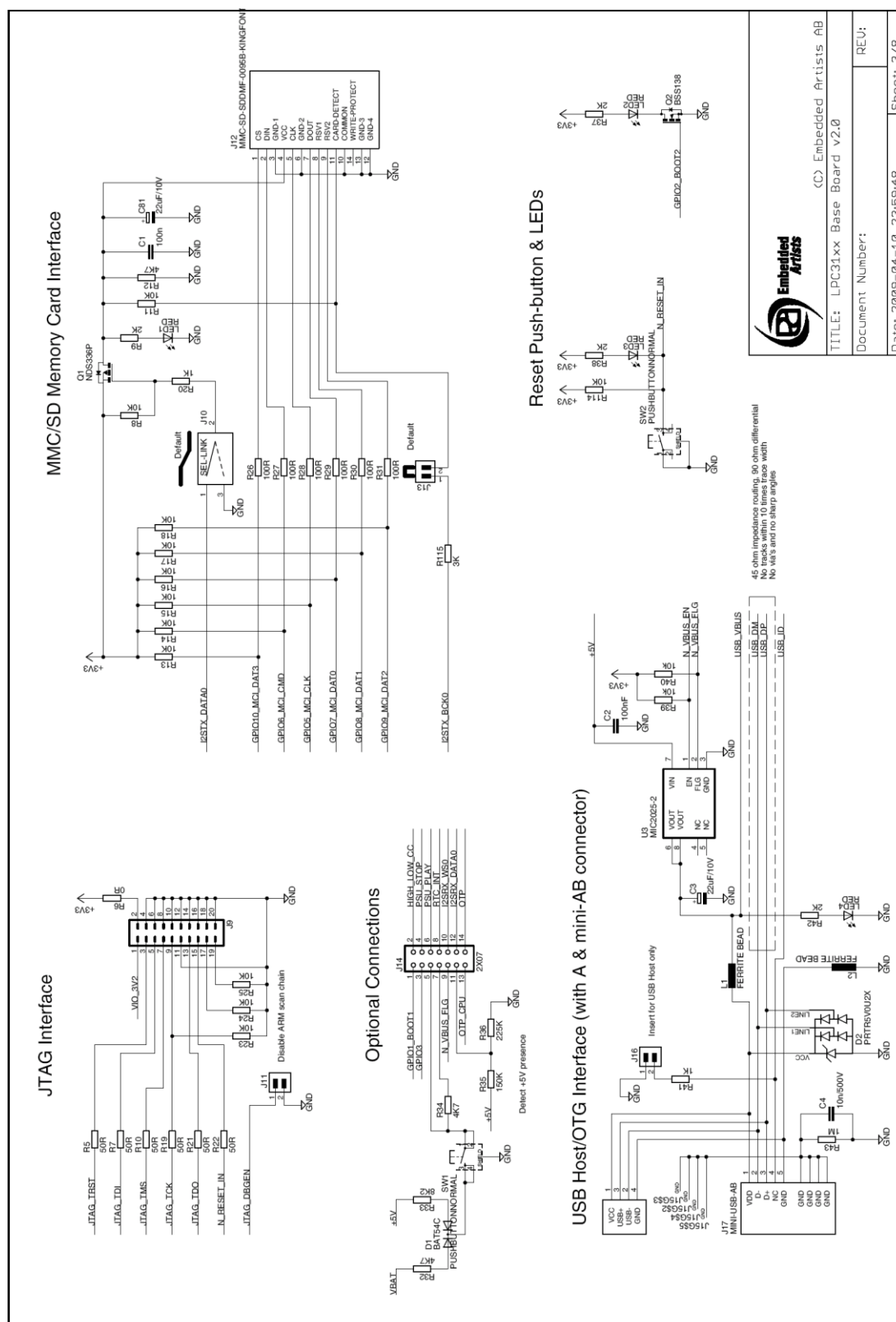


Figure 9 – LPC31xx Base Board Schematic, v2.0, page 3

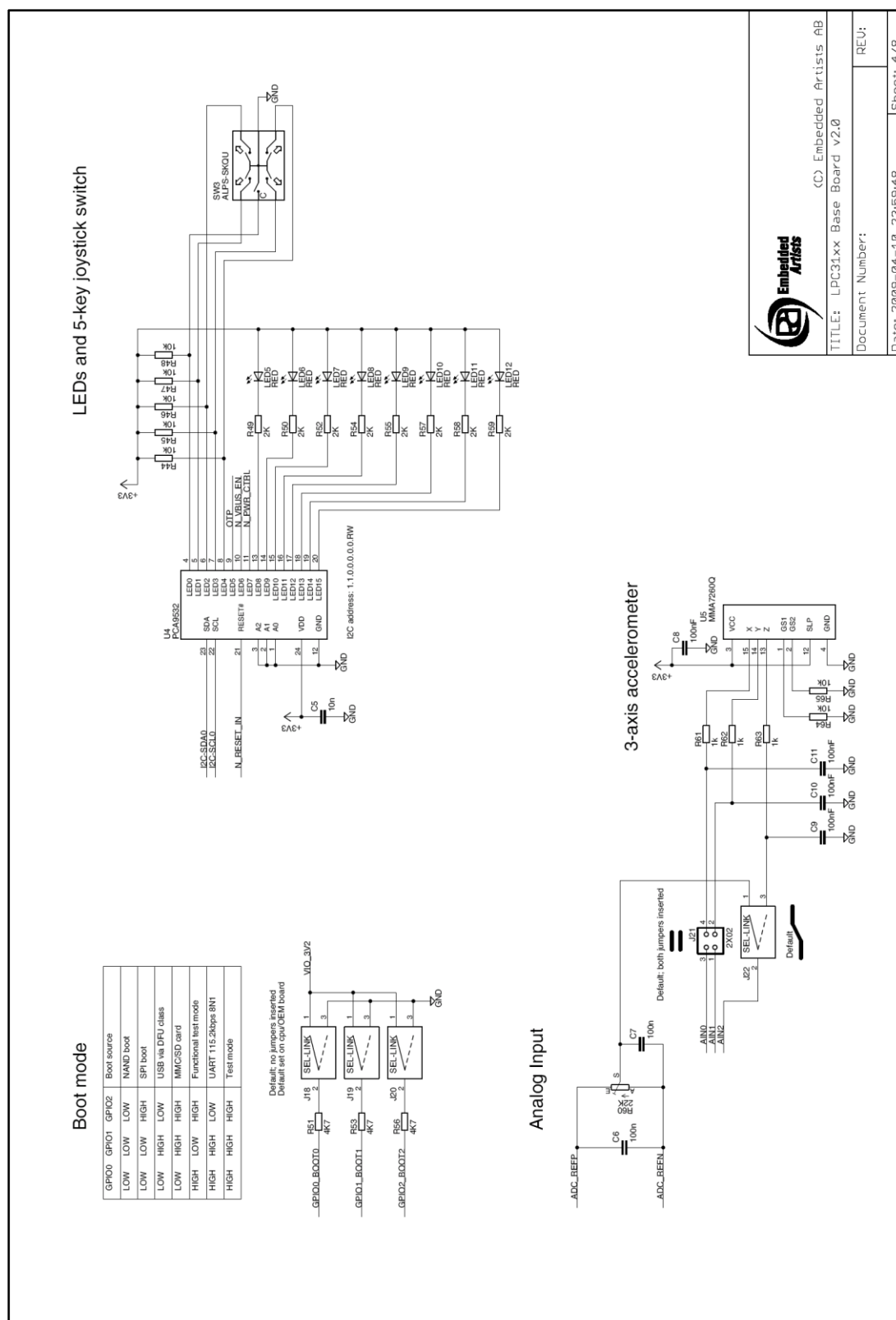


Figure 10 – LPC31xx Base Board Schematic, v2.0, page 4

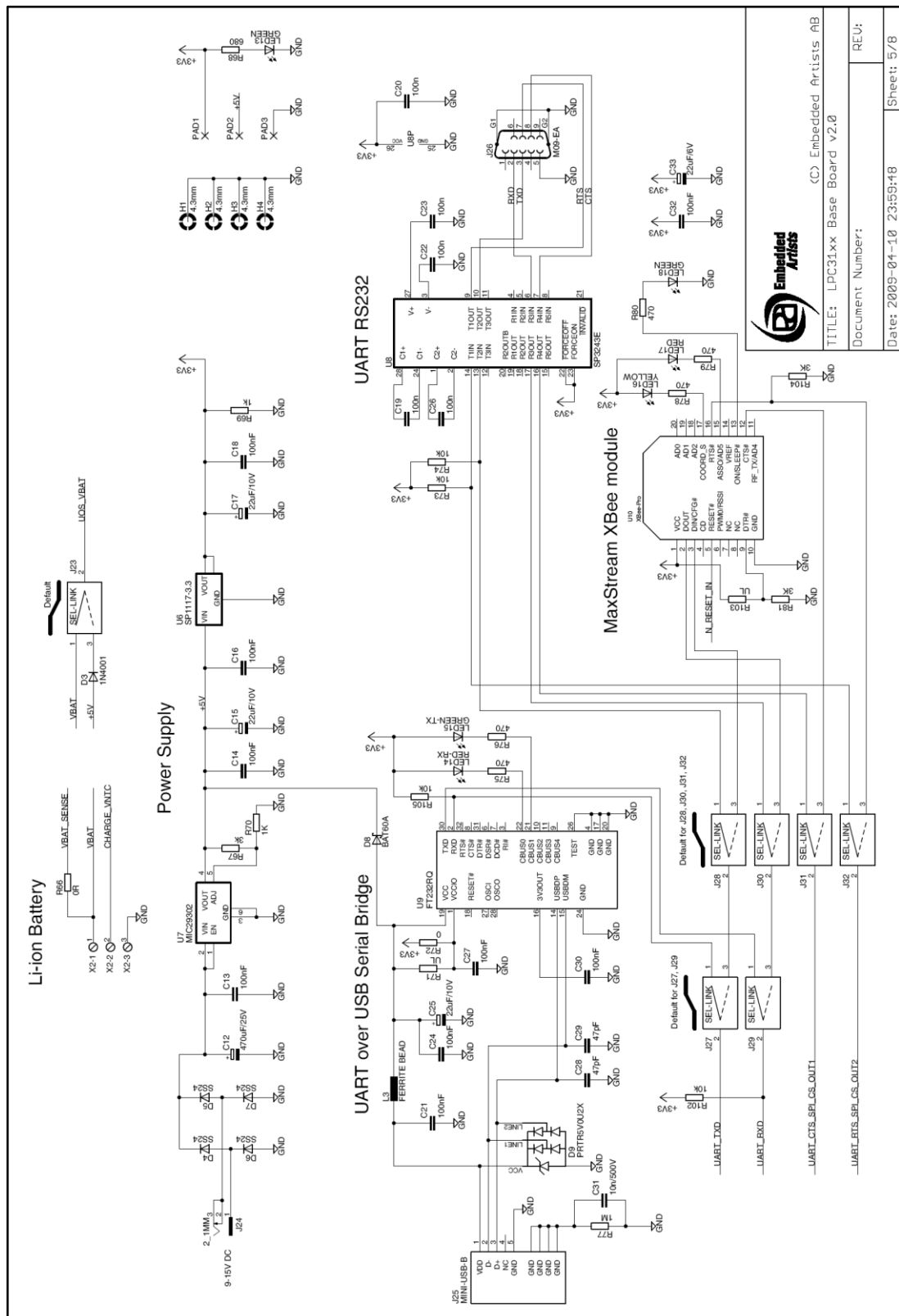


Figure 11 – LPC31xx Base Board Schematic, v2.0, page 5

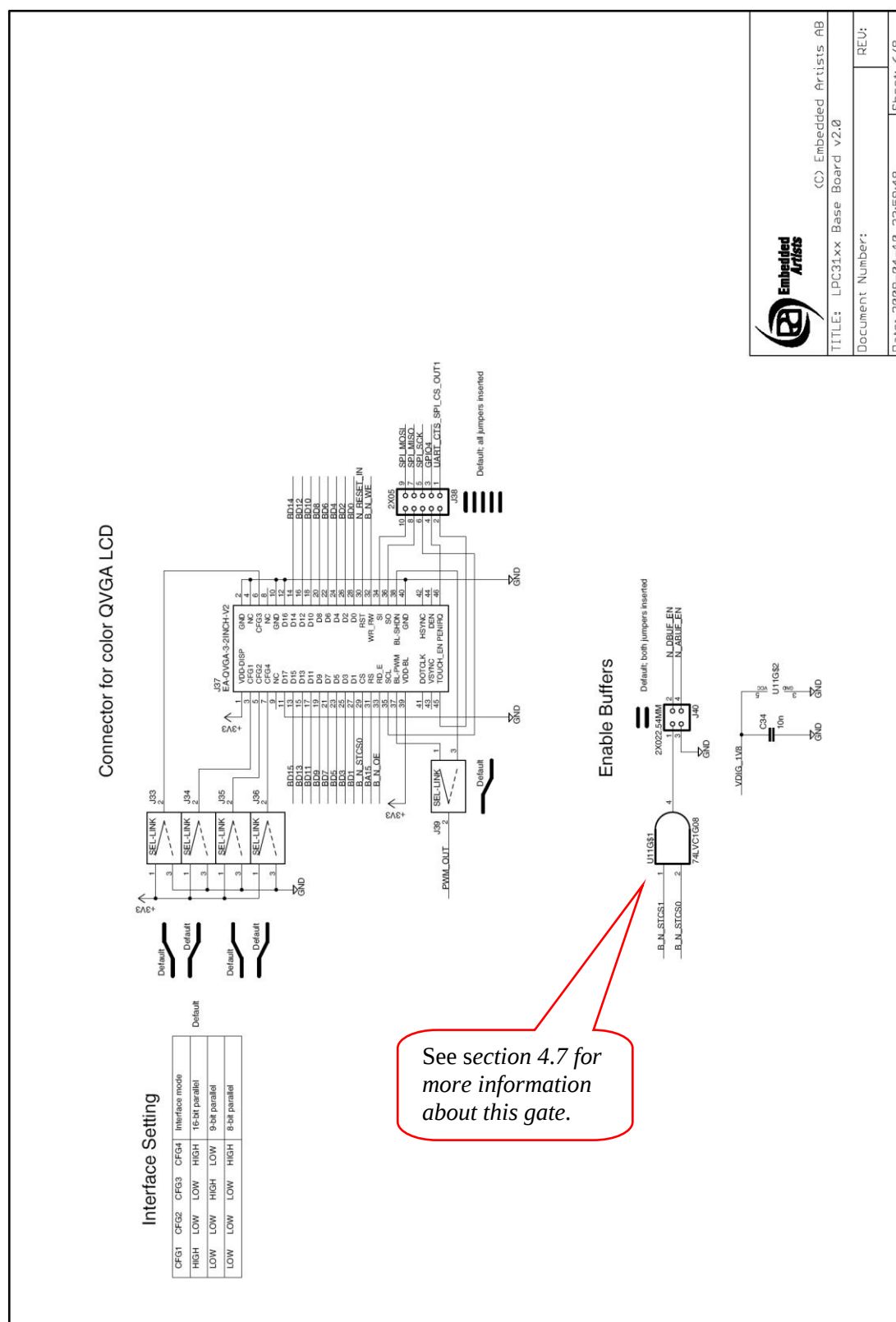


Figure 12 – LPC31xx Base Board Schematic, v2.0, page 6

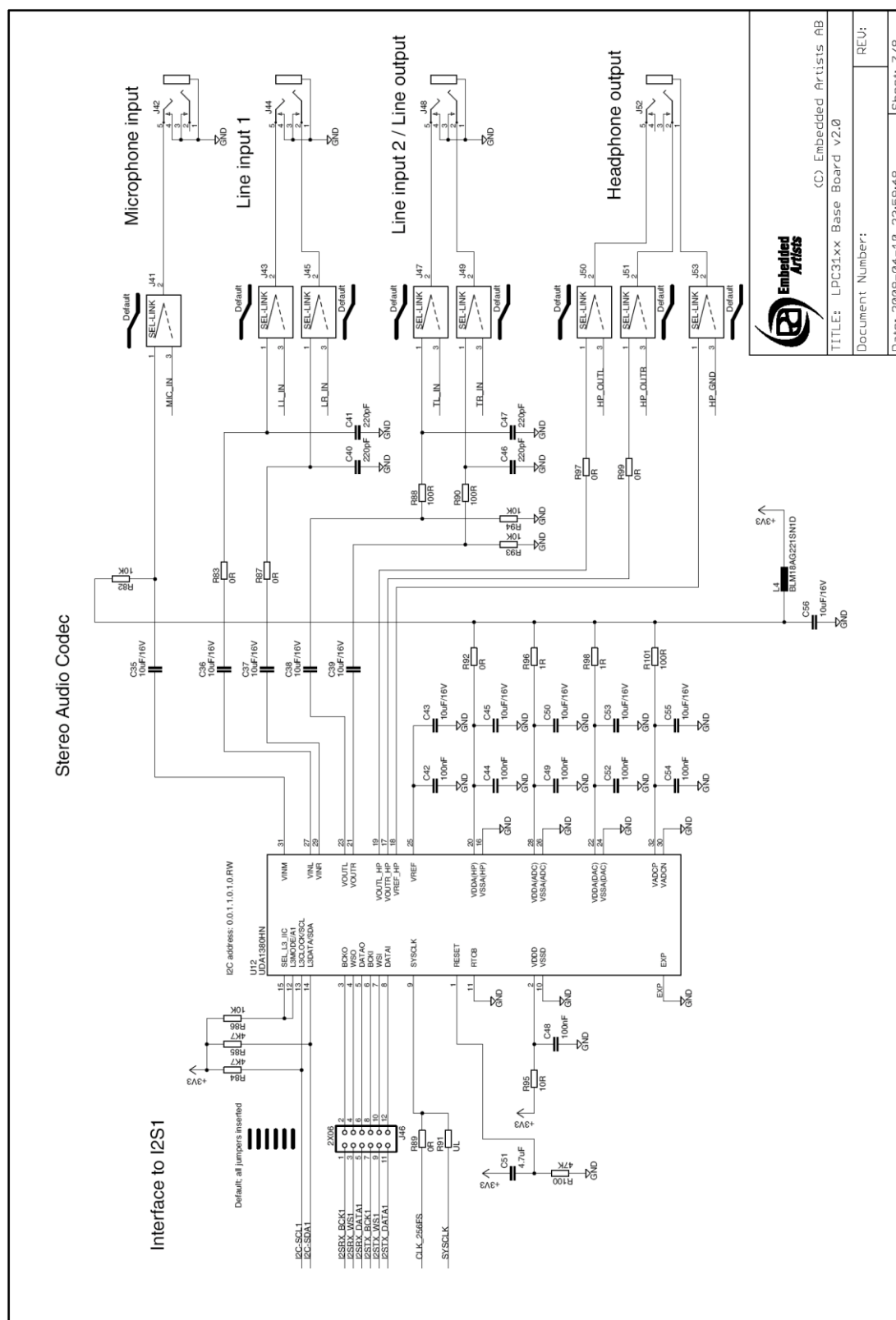


Figure 13 – LPC31xx Base Board Schematic, v2.0, page 7

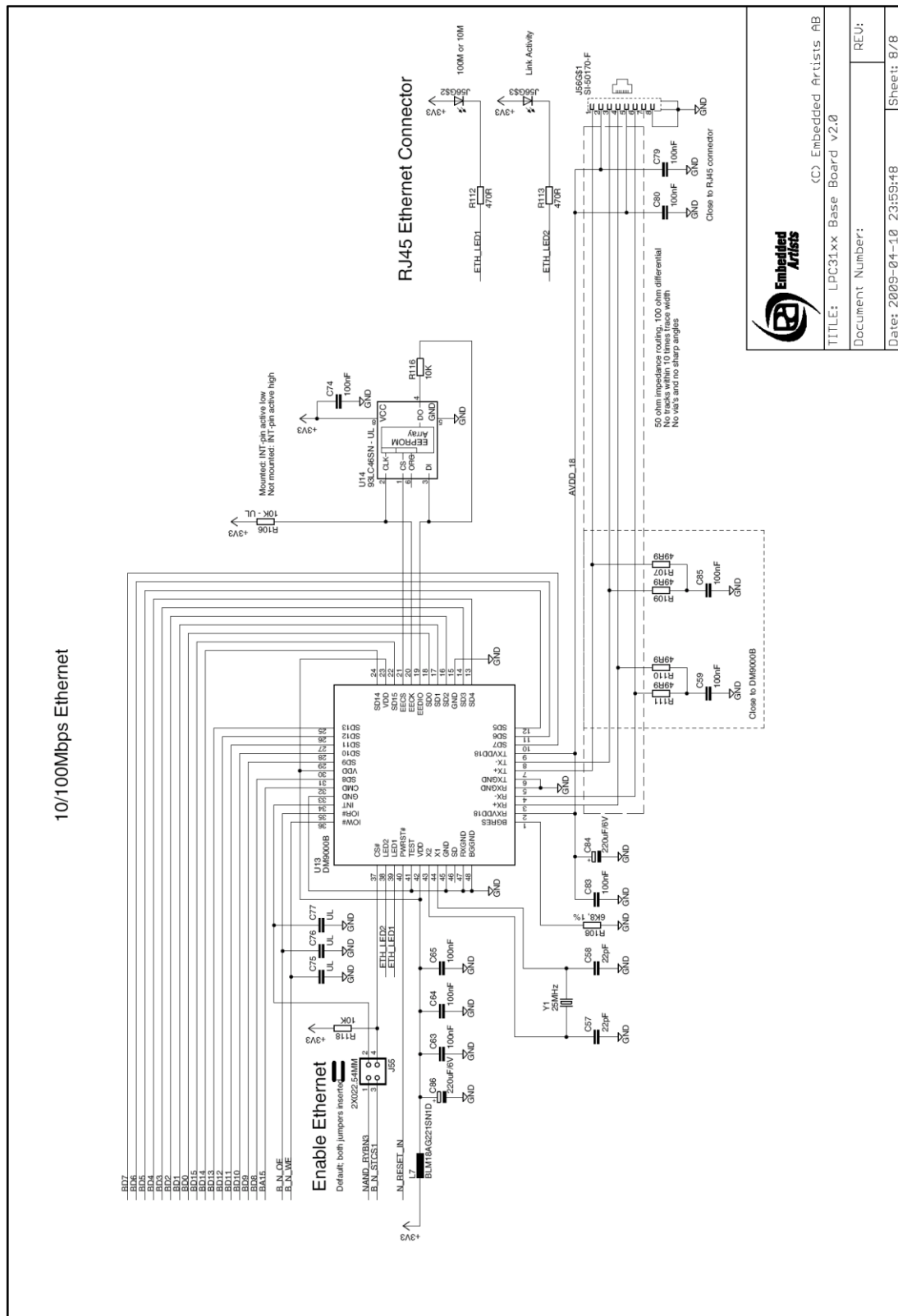


Figure 14 – LPC31xx Base Board Schematic, v2.0, page 8

The *LPC31xx Base Board* contains a number of interfaces and connectors to the *LPC3131/41 OEM Board*. The design can be viewed as a reference schematic for custom designs around the *LPC3131/41 OEM Board*.

Note that there is some future functionality on the *LPC31xx Base Board*, which does not directly apply for the *LPC3131/41 OEM Board*.

4.2 Usage of CPU Pins

Almost all pins of the LPC3131/41 are directly available on the expansion connectors. Only in a few cases are pins used for dedicated functionality like (dynamic) memory control signals and chip select signals. Such pins are not available on the expansion connector. The table below lists all pins and their possible restrictions.

Pin	Usage on LPC31xx Base Board
USB_VBUS USB_DM USB_DP USB_ID	Connected to USB connectors; mini-AB and A.
I2C_SDA0 I2C_SCL0	Connected to PCA9532 port expander.
I2C_SDA1 I2C_SCL1	Connected to UDA1380 codec for controlling the codec.
SPI_SCK SPI_MISO SPI_MOSI	Can be connected to QVGA display for touch screen controller SPI interface.
SPI_CS_IN	No usage.
UART_RXD UART_TXD	Can be connected to the USB-to-serial bridge, RS232 interface or XBee module.
UART_CTS/SPI_CS_OUT1	Can be connected to QVGA display for touch screen controller SPI interface (chip select). Can be connected to RS232 interface or XBee module.
UART_RTS/SPI_CS_OUT2	Can be connected to RS232 interface or XBee module.
I2SRX_DATA0	Can be used to detect presence of +5V.
I2SRX_WS0	Can be used to detect USB power switch over-current status
I2SRX_BCK0 I2STX_WS0	No usage.
I2STX_DATA0	Can be used to control powering of MMC/SD memory card interface.
I2STX_BCK0	Can be used to detect MMC/SD memory card presence.
I2SRX_DATA1	Can be connected to UDA1380 codec.

I2SRX_WS1 I2SRX_BCK1 I2STX_DATA1 I2STX_WS1 I2STX_BCK1	
GPIO0 GPIO1 GPIO2	Can be connected to jumpers for controlling boot mode.
GPIO3	No usage.
GPIO4	Can be used as QVGA display touch screen controller interrupt pin.
GPIO5	Can be used as MCI_CLK (MMC/SD interface)
GPIO6	Can be used as MCI_CMD (MMC/SD interface)
GPIO7	Can be used as MCI_DAT0 (MMC/SD interface)
GPIO8	Can be used as MCI_DAT1 (MMC/SD interface)
GPIO9	Can be used as MCI_DAT2 (MMC/SD interface)
GPIO10	Can be used as MCI_DAT3 (MMC/SD interface)
GPIO11-GPIO20	No usage.
PWM_DATA	Can be used to control backlight intensity on QVGA display
ADC10B_GPA0	X-output from accelerometer.
ADC10B_GPA1	Y-output from accelerometer.
ADC10B_GPA2	Either z-output from accelerometer or trim pot.
ADC10B_GPA3	No usage.
CLK_256FS_O	256 Fs clock to UDA1380 codec.
CLOCK_OUT SYSCLK_O	No usage.
EBI_D0-EBI_D15	Connect to QVGA display module connector and DM9000 Ethernet interface.
MLCD_A0/ALE MLCD_A1/CLK MLCD_DB2/EBI_A2 MLCD_DB3/EBI_A3 MLCD_DB4/EBI_A4 MLCD_DB5/EBI_A5 MLCD_DB6/EBI_A6 MLCD_DB7/EBI_A7 MLCD_DB8/EBI_A8 MLCD_DB9/EBI_A9 MLCD_DB10/EBI_A10 MLCD_DB11/EBI_A11 MLCD_DB12/EBI_A12	No usage.

MLCD_DB13/EBI_A13 MLCD_DB14/EBI_A14	
MLCD_DB15/EBI_A15	Connect to QVGA display module connector and DM9000 Ethernet interface.
EBI_DQM0/NOE EBI_NWE MLCD_CSB/EBI_NSTCS0	Connect to QVGA display module connector and DM9000 Ethernet interface.
MLCD_DB1/EBI_NSTCS1	Connect to DM9000 Ethernet interface.
EBI_NCAS/BLOUT0 EBI_NRAS/BLOUT1	No usage.
NAND_NCS1 NAND_NCS2 NAND_NCS3 MNAND_RYBN1/MCI_DATA5 MNAND_RYBN2/MCI_DATA6 MNAND_RYBN3/MCI_DATA7	No usage.
ADC_REFP ADC_REFN	Used as references to generate analog signal from trip pot.
JTAG signals	Connected to standard ARM 2x10 pos JTAG connector.
RESET_IN	Connected to Reset push-button and LED.

4.3 Known Limitation / Things to note about the LPC31xx Base Board

4.3.1 Codec Usage and Boot Mode

The codec, uda1380 (U12), communicate audio data over the I2S bus and command/setting data over the I2C1 bus. Transferring I2S data reliable from the codec to the LPC3131/41 requires booting from JTAG or USB. UART and SPI booting can create an unreliable connection. The problem is under investigation. Transferring I2S data to the codec works.

The I2C address of the UDA1380 is also important to understand. The default I2C slave address of LPC313x/4x/5x is the same as the address assigned to UDA1380 on LPC31xx Base Board. Due to this whenever LPC313x/4x/5x as master tries to access UDA1380 the slave logic inside the LPC313x/4x/5x is also reacting causing I2C bus errors. For write this is not a bit problem but for register reads it is. The software running on the LPC313x/4x/5x should change the default I2C slave address before doing any I2C transactions to the UDA1380 on the LPC31xx Base Board. This is done by setting register I2C0_ADR (0x1300A014) & I2C1_ADR (0x1300A414) to 0x6E. The default value for this register is 0x1A (earlier LPC313x User's Manual has had wrong information about default address, i.e., it is not 0x6E).

4.3.2 NAND Booting

Read *section 4.7* for details about N_DBUF_EN signal during NAND boot.

4.3.3 SD/MMC card detect

The pull-up on SD card detect pin is after the power switch. Due to this there is a need to enable power to the SD/MMC slot to even detect the card insertion.

4.3.4 USB Host applications

When running USB Host applications where the external USB Device draw a considerable amount of current ($>100\text{mA}$), the LPC31xx Base Board must be powered with an external power supply (as opposed to being powered via the USB-to-UART mini-B USB connector). See section 5.1 for details about the external power supply.

4.4 Jumpers

The *LPC31xx Base Board* has a number of jumpers in order to be able to connect/disconnect and fully utilize all functionality of the LPC3131/41 and the *LPC31xx Base Board*. Figure 15 below illustrates all jumpers and explains to what part of the design they belong. Note that v2.0 of the board is shown. V1.0 and v1.1 lack the Ethernet functionality but are equal in all other aspect.

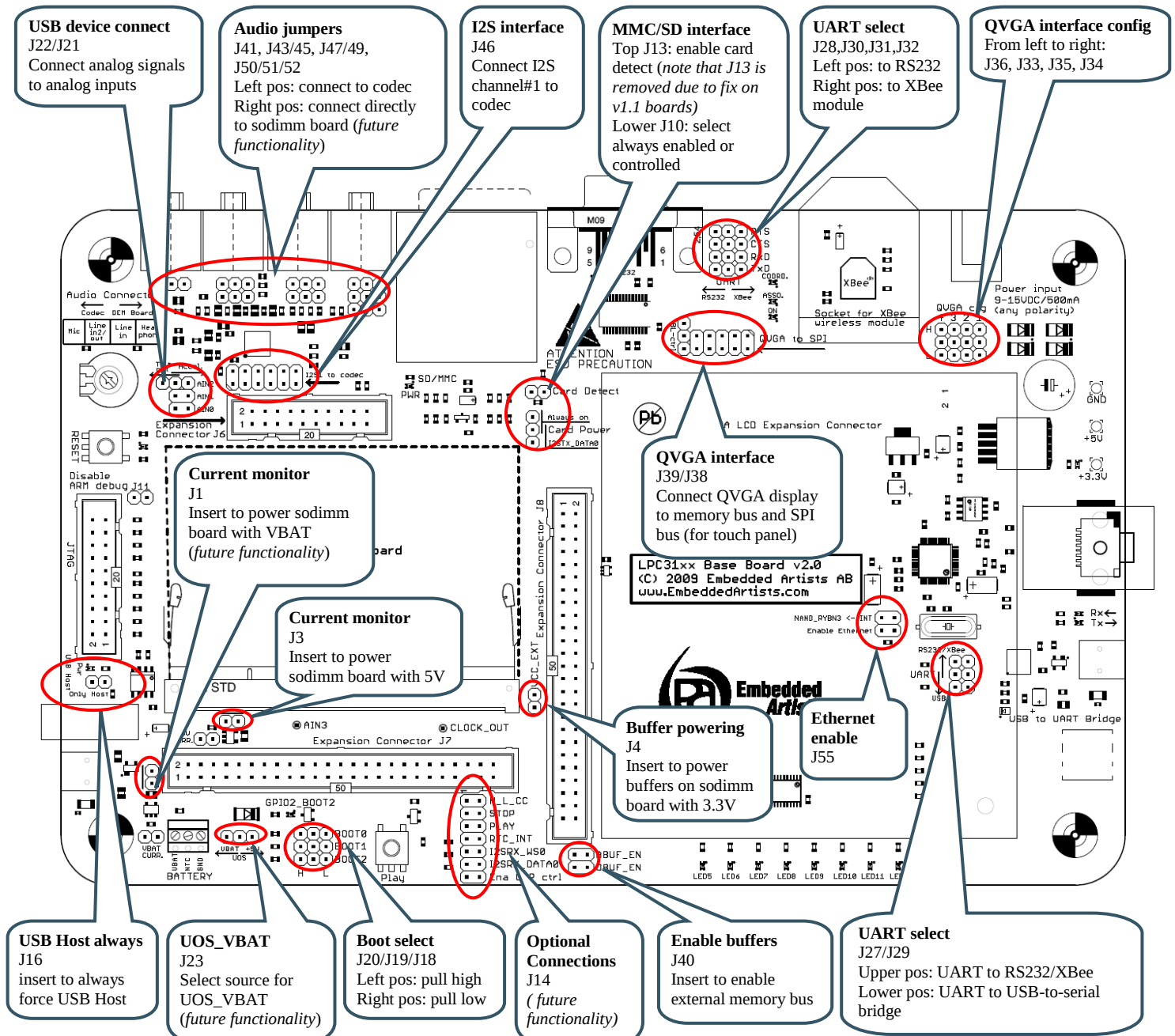


Figure 15 – LPC31xx Base Board Jumper Positions

4.4.1 Default Jumper Positions

Figure 16 below illustrates the default jumper positions as mounted when the board is delivered from Embedded Artists.

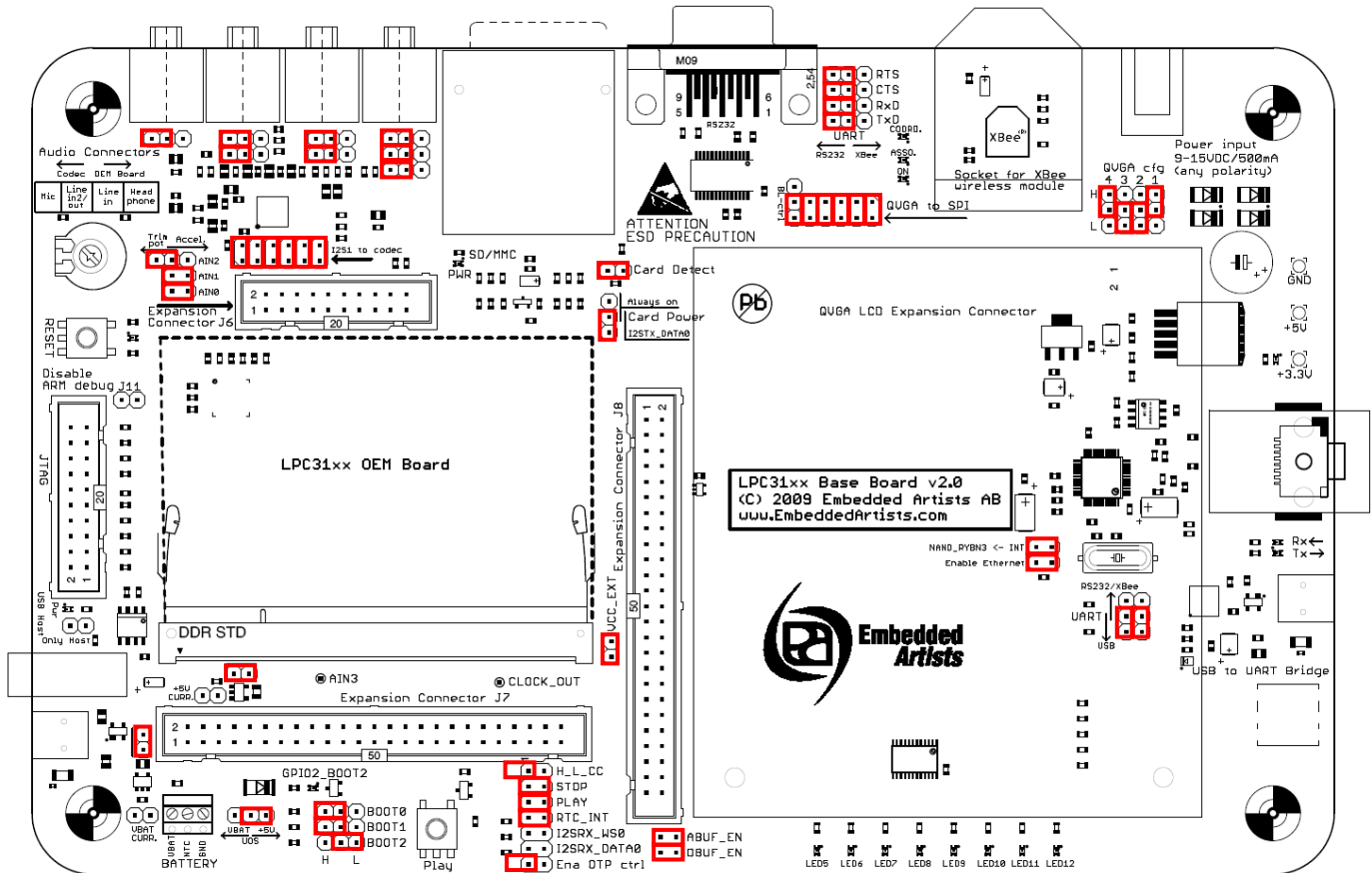


Figure 16 – LPC31xx Base Board Default Jumper Positions

4.4.2 Illegal Jumper Combinations

Note that some jumpers are mutual exclusive and should not be inserted simultaneously.

- Note that the spi chip select on the QVGA display touch controller use the signal UART_CTS_SPI_CS_OUT1. Hence, a jumper between pin 1-2 on J38 should not be inserted while a jumper on J31 is inserted since RTS from the RS232 interface or CTS# from the XBee module will also drive this signal.

4.5 Connectors

Figure 17 below illustrate the position of all external connectors on the *LPC31xx Base Board*.

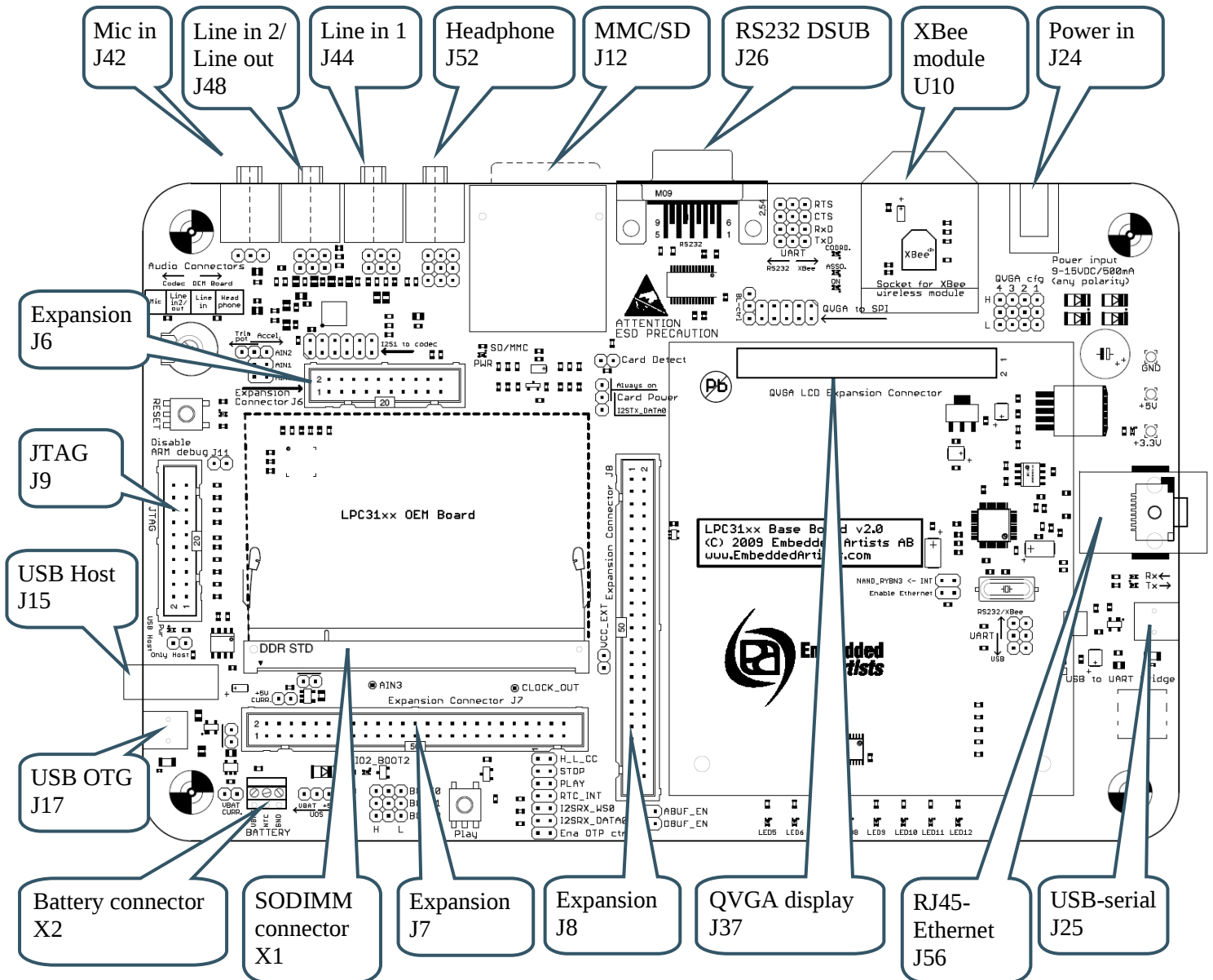


Figure 17 – LPC31xx Base Board External Connectors

4.6 Important Components

Figure 18 below illustrates the position on the *LPC31xx Base Board* for some important components in the design.

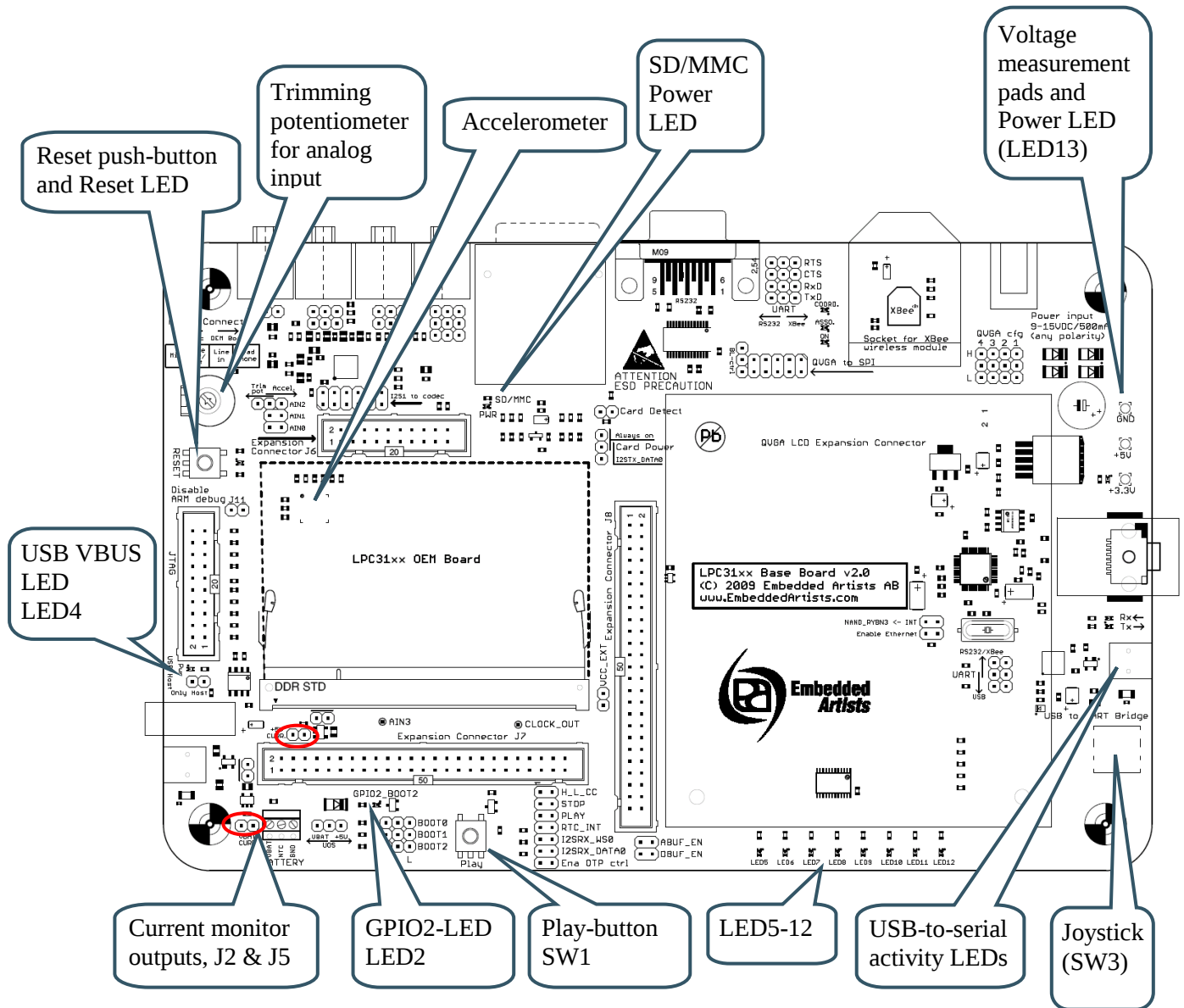


Figure 18 – LPC31xx Base Board Important Components

4.7 NAND Boot Problem Fix

This note does **NOT** affect boards marked with WO-0246-1033. See picture below where to find production marking. The picture illustrates a board that is not affected. The last four numbers represent a year-week marking. '1033' means produced: 2010, week 33. Boards marked with production dates earlier than 1033 **are** affected.

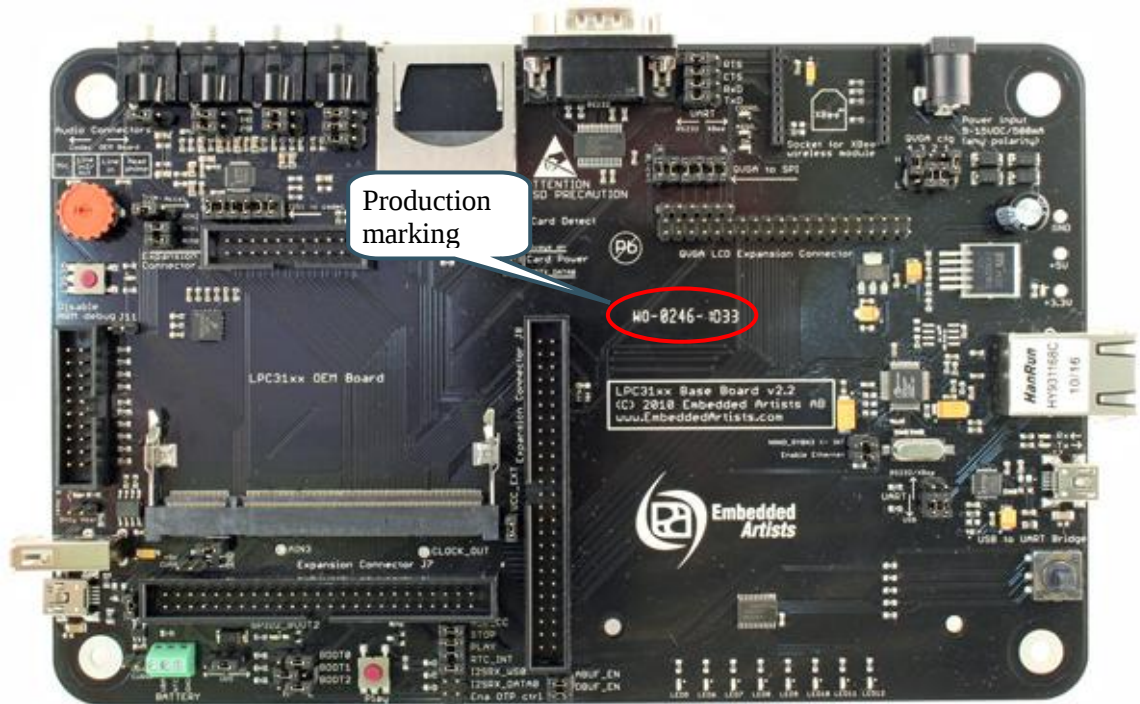


Figure 19 – LPC31xx Base Board Production Marking

Note that there is a conflict on the databus when booting via NAND flash. The problem is that signals N_STCS0 and N_STCS1 are low during NAND boot. The signal DBUF_EN on the *LPC31xx Base Board* is formed by AND:ing N_STCS0 and N_STCS1. This, in turn, enables the databus buffer (U16 on *LPC3131/41 OEM Board*) when the DBUF_EN jumper (pin 1-2 on J40) is inserted on the *LPC31xx Base Board*. See *Figure 20* to locate DBUF_EN jumper on the *LPC31xx Base Board*.

After NAND flash boot is completed the active level changes for the signals N_STCS0 and N_STCS1. Their inactive state is then high and their active state is low, just as expected for memory bus chip select signals. There is unfortunately no way to detect when the NAND boot process is complete. There are however two workarounds for this problem:

1. Remove the DBUF_EN jumper during the boot process and then insert the jumper again in order to use the QVGA and Ethernet functionality on the *LPC31xx Base Board*.

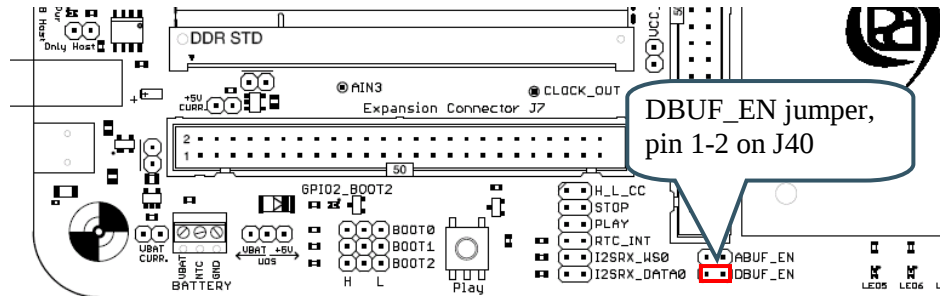


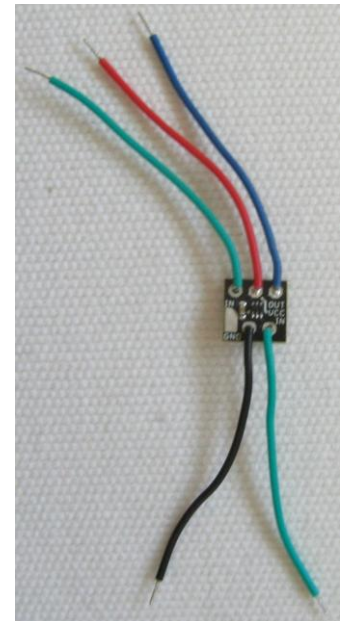
Figure 20 – DBUF_EN jumper location on LPC31xx Base Board

2. Replace U11 (74LVC1G08), the AND gate found on page 6 of the *LPC31xx Base Board* schematic. Replace it with a XNOR-gate. The AND and XNOR gates have the same truth table except when both input signals are low. For the XNOR gate the output is high when both inputs are low. This will also solve the problem, since the databus buffer (U16 on *LPC3131/41 OEM Board*) will not be enabled during NAND boot when both N_STCS0 and N_STCS1 are low.

Embedded Artists has created a small board with a XNOR gate that can be soldered to the *LPC31xx Base Board*. This board can be ordered free of charge from the [support page](#). The board is delivered with a detailed instruction how to solder the board (5 wires needs to be soldered on the back side of the *LPC31xx Base Board*).

The picture to the right shows the small board with the XNOR gate.

After the small board has been soldered to the back side of the *LPC31xx Base Board*, the DBUF-EN jumper (pin 1-2 on J40) shall **NOT** be inserted.



5 Getting Started

This chapter contains information about how to get acquainted with the *LPC3131/41 OEM Board and LPC31xx Base Board Bundle*. **Please read this section first before you start using the board - it will be worthwhile!**

5.1 Initial Setup and Powering

The board can be powered from a PC via the included USB cable (mini-B to A cable). A separate power supply is however needed in stand-alone situations or when running USB Host application (when powering heavy load external USB devices). The power supply should be 9-15V DC, 2 Amp. A 2.1mm standard power plug is used to interface the board. Any polarity is accepted.

It is possible to have both the USB cable and external powering connected to the board at the same time.

The *LPC31xx Base Board* contains a USB-to-Serial bridge chip (FT232R from FTDI) that connects the UART channel on the LPC3131/41 to a virtual COM port on the PC (via USB). It is this serial channel that is the console interface to the system.

Special USB drivers must be installed on the PC in order for the virtual COM port to be created. See *Section 5.2* for a description of how to install the FTDI USB driver.

5.2 FTDI USB Driver

A USB driver must be installed on your PC computer in order to get the USB-to-UART chip (FT232R) to function. Make sure to download the latest version of the driver, which can be found at the following URL: <http://www.ftdichip.com/Drivers/VCP.htm> (search for a FT232R driver for your operating system).

When the *LPC31xx Base Board* is connected to the PC (via an USB cable) the PC will ask for a driver. Unpack/unzip the downloaded driver file and browse to the position of the driver files. After successful driver installation, a COM port will be created. Before any communication with the Board can take place the UART settings must be correctly set. The following description is valid for Windows™ XP, but other operating systems have similar dialog windows. See the USB driver documentation for details, if needed.

To change the UART settings, first open the System Properties dialog, as illustrated in the figure below.

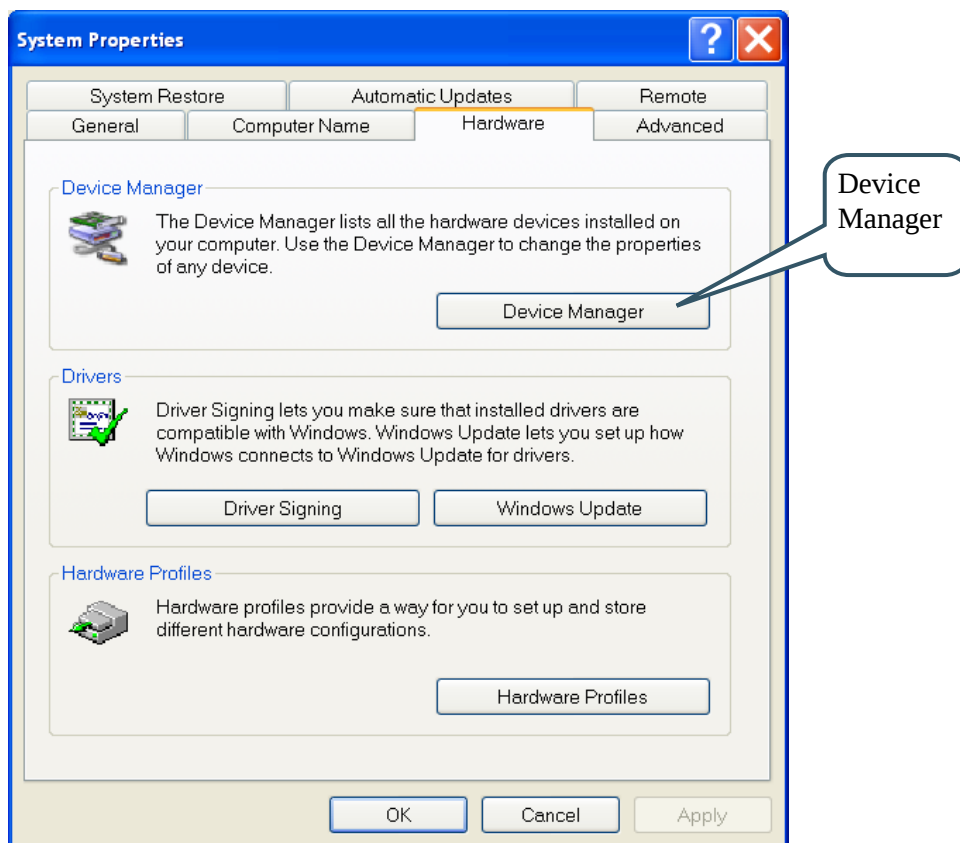


Figure 21 – System Settings Dialog

Then select the *Device Manager* and open the *Ports* list, as illustrated in Figure 22 below.

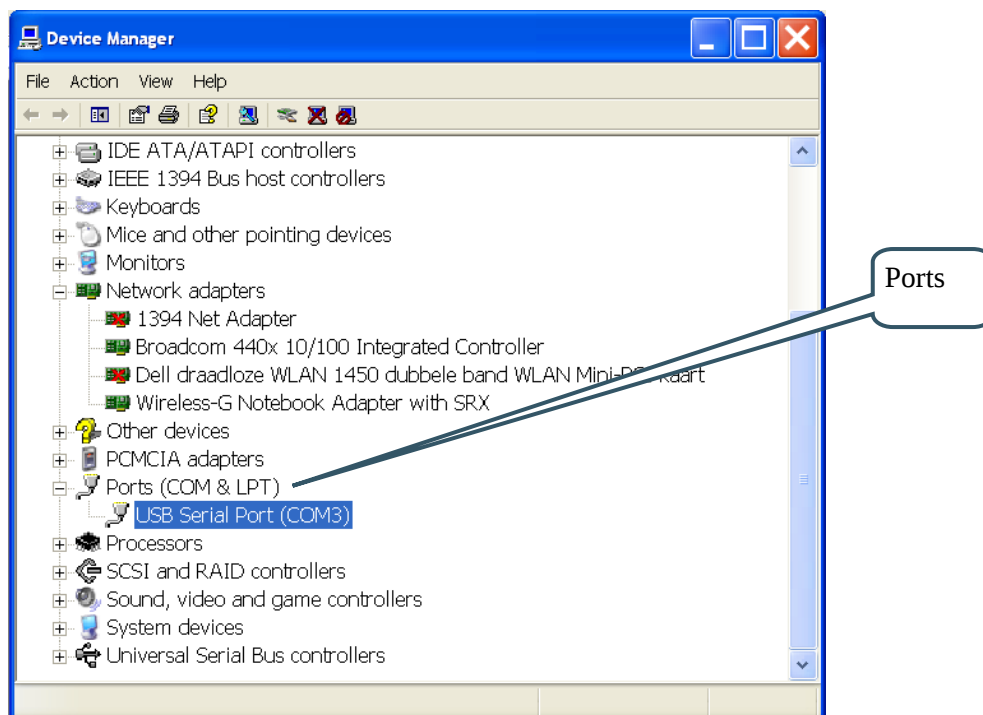


Figure 22 – Device Manager Dialog

The new COM port (USB Serial Port) will be listed under the *Ports* list. Right-click on the new USB Serial Port and select *Properties*, as illustrated in *Figure 23* below.

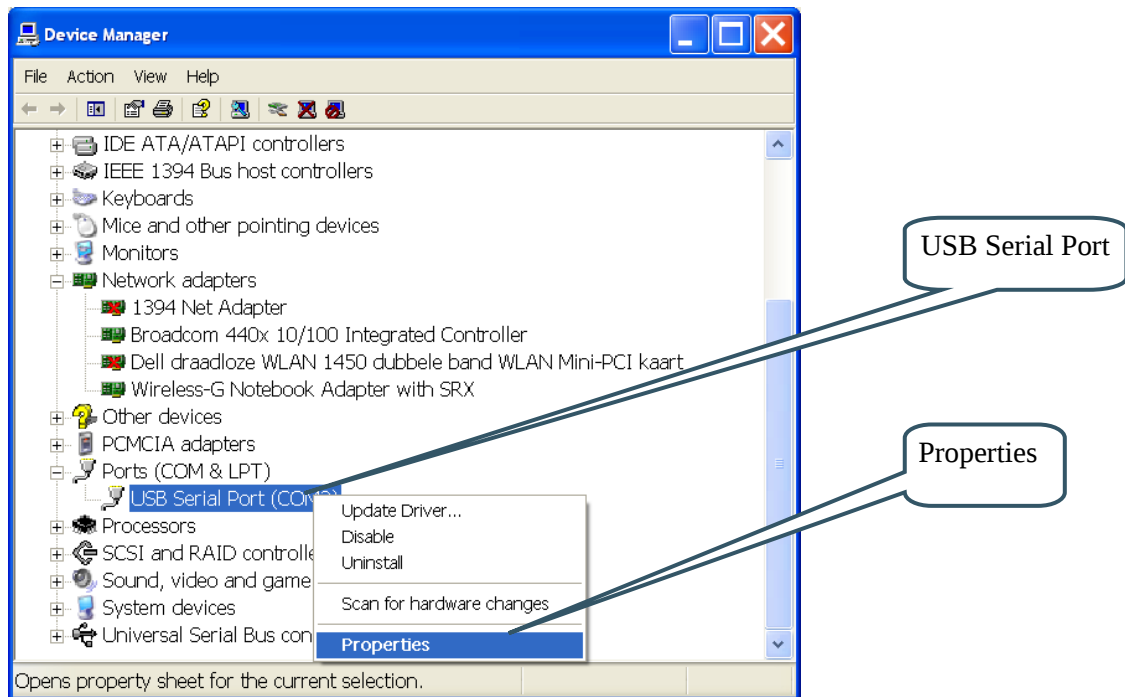


Figure 23 – Device Manager Port Dialog

Select 115200 bits per second, 8 data bits, none parity, 1 stop bit, and none flow control, as illustrated in *Figure 24* below. Then select *Advanced* settings. Please note that different application programs can use different baudrate settings for the serial channel. Other baudrates can also be used, depending on your specific application.

Also note that it is normally not needed to set the used baudrate at all. The driver and FT232R chip will automatically handle different baudrates. The setting is only shown here for completeness.

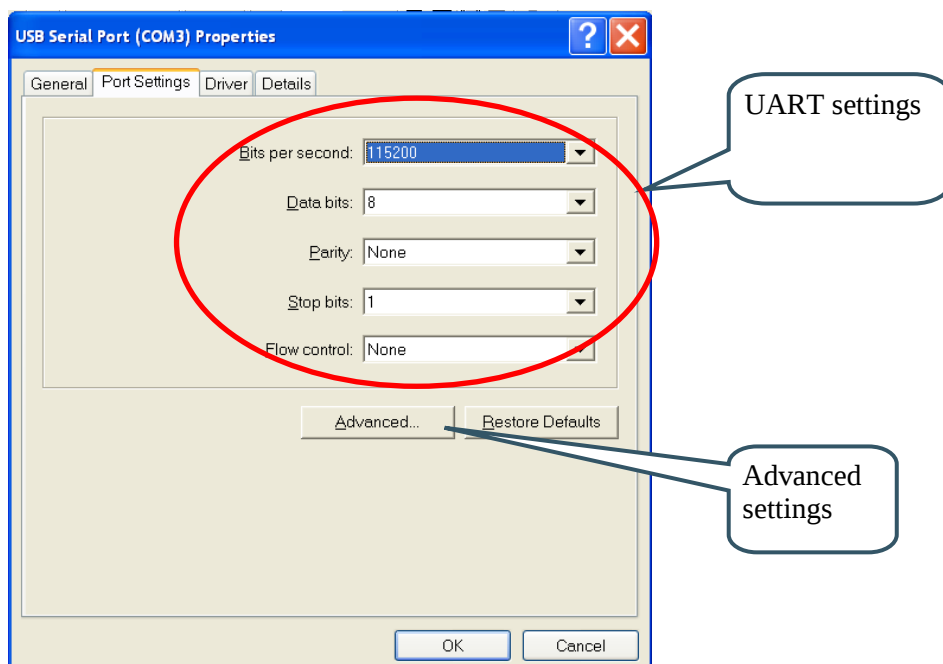


Figure 24 – USB Serial Port Properties Dialog

Select the desired COM port number under the *Advanced* settings dialog. NXP's FLASH Utility program (for ISP program download) needs, for example, a COM port number between 1 and 5. Very often the COM port number is selected but the USB Serial Port is higher than this, therefore this need to be changed manually.

It is common that all COM ports with low numbers are listed as occupied, but test to change to a low number anyway. Very often it is no problem at all to do so.

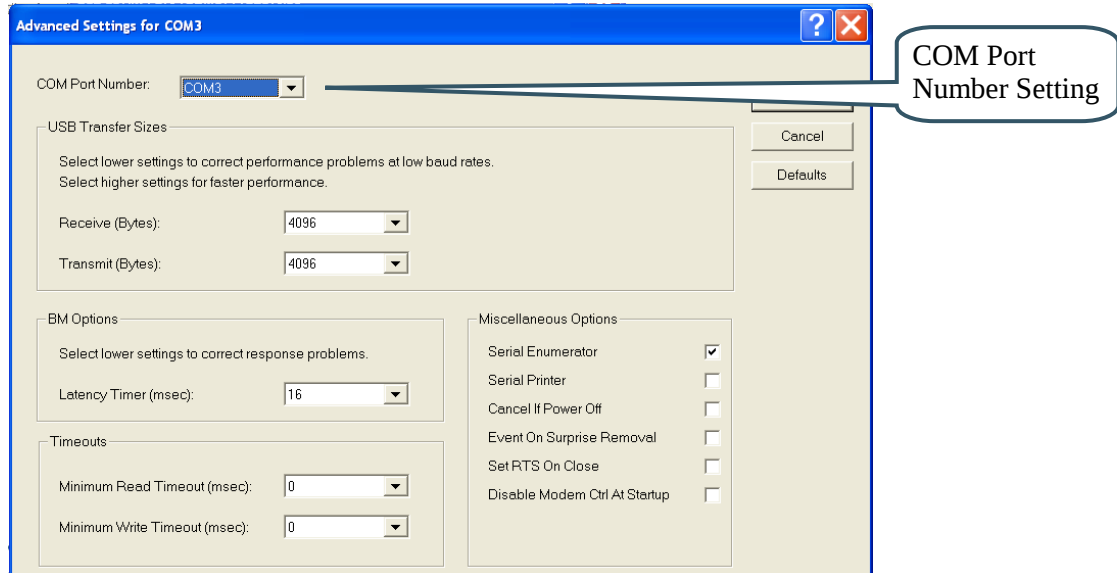


Figure 25 – Advanced USB Serial Port Properties Dialog

Finally it is time to test if you have successfully installed and configured the USB Serial Port. Start a terminal program. Connect to the correct COM port, with 115200 bits per second, 8N1, no flow control.

5.2.1 USB Driver Behavior

Sometimes the USB COM port does not enumerate properly when the board is connected to the PC. This is a known “feature” of the USB driver. If you experience this problem, just unplug the board shortly and then plug in again. A new COM port that can be accessed properly should be created the second time.

This problem may occur after every time you start (i.e., power cycle) your PC.

5.3 Booting

The processor will start its code execution from an internal ROM, containing the boot code. This code determines the boot mode by sampling the reset state of the pins GPIO0, GPIO1 and GPIO2. Multiple boot options are supported:

- Booting from different sources; SPI flash, NAND flash, SD/SDHC/MMC cards, UART and USB (DFU class) interfaces
- Option to perform CRC32 checking on the boot image

The boot code copies/downloads the boot image to internal SRAM at location 0x1102 9000 and jumps to that location (sets ARM's program counter register to 0x1102 9000) after image verification. Hence the boot images should be compiled with entry point at 0x1102 9000. The boot code can handle boot images up to 128 kByte in size on the LPC3131/41. For larger applications, the booting has to be done in more steps, i.e., a second stage boot loader has to be added.

Note that the boot code initializes the MMU (Memory Management Unit) with a pre-defined MMU table. This table is 16 kByte in size, so systems with RAM constraints (or small and

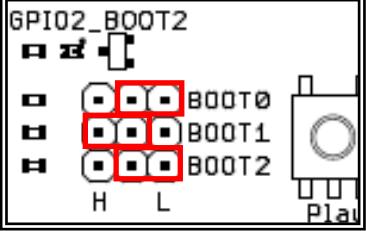
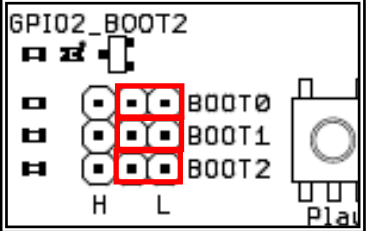
simple systems) can utilize this pre-defined MMU table. If this is not sufficient, the MMU must be further initialized in the beginning of the user code (i.e., the boot image).

The LPC3131/41 User's Manual from NXP contains all details about booting including the pre-defined MMU table. The rest of this section gives an overview of what is supported by the *LPC3131/41 OEM Board* and *LPC31xx Base Board*, and how to quickly get started with the download process.

5.3.1 Jumper Settings

The table below lists the boot sources supported by the *LPC3131/41 OEM Board* and how to set the jumpers on the *LPC31xx Base Board*.

Way of booting (source for boot image)	Jumper settings (on <i>LPC31xx Base Board</i>)	Description
UART (default mode)		The boot image is downloaded via the UART. The download format is 115.2 kbps, 8 data bits, no parity and one stop bit (8N1). It is recommended to download a CRC check boot image since there is no flow control or handshake mechanism implemented in the UART protocol. Note that no jumpers need to be set for this boot mode since this is the default. However, it is good practice to set the jumpers anyways, since future revisions or special versions of the <i>LPC3131/41 OEM Board</i> might change default boot mode.
SPI NOR flash		The boot image is stored on the SPI NOR flash. A CRC check boot image should be used. The boot image is downloaded into SPI NOR flash with the help of a special loader application. For a description of how this could be done, see further down in this section.
MMC/SD		The boot image is stored on a MMC/SD memory card. See the LPC3131/41 User's Manual from NXP for details about how to format and prepare the memory card.

USB – DFU class		The boot image is downloaded via the USB by utilizing the DFU class (Device Firmware Upgrade). A Windows application exists that connect to the DFU device (that the LPC3131/41 implements in boot mode). This application is used to download the boot image. Note that a special format of the boot image must be used. For a description of how this could be done, see further down in this section.
NAND flash		The boot image is stored on the NAND flash. The boot image is downloaded into NAND flash with the help of a special loader application. At the time of writing, no such application has been created. Read section 4.7 about NAND boot issue when using QVGA display and Ethernet controller on LPC31xx Base Board.

5.3.2 Creating a Boot Image

This section describes how to create a boot image for the LPC31xx processor family. Three IDE:s are described (GCC, EWARM from IAR and uVision from Keil). Note that similar settings can be done in IDE:s from other vendors and should in general be no problem to implement.

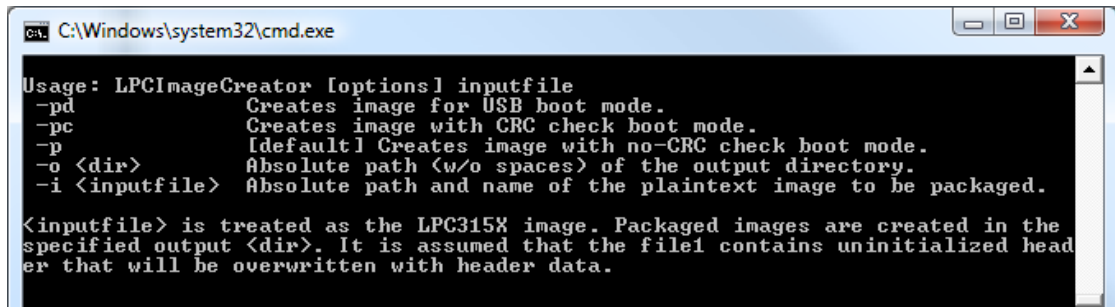
5.3.2.1 GCC

The first step is to create a pure binary file. This is normally done from the build output file (often an elf or elf-compatible file).

Under a GCC environment, the command to create a binary file, named *lpc313x.bin* is:

```
arm-elf-objcopy -I elf32-little -O binary --strip-debug
--strip-unneeded --verbose <input-file> lpc313x.bin
```

The second step is to create a CRC attached boot image for the LPC3131/41. There is a command line tool from NXP, bundled in the CDL package named: *lpc313xImgCreator*. See program output explaining the command line options below.



```

C:\Windows\system32\cmd.exe

Usage: LPCImageCreator [options] inputfile
-pd      Creates image for USB boot mode.
-pc      Creates image with CRC check boot mode.
-p       [default] Creates image with no-CRC check boot mode.
-o <dir> Absolute path (w/o spaces) of the output directory.
-i <inputfile> Absolute path and name of the plaintext image to be packaged.

<inputfile> is treated as the LPC315X image. Packaged images are created in the
specified output <dir>. It is assumed that the file contains uninitialized header
data that will be overwritten with header data.
  
```

Figure 26 – lpc313xImgCreator Command Line Options

To add a CRC header to the binary file, i.e., to create a CRC attached boot image, the command is:

```
lpc313xImgCreator -o ./ -pc -i lpc313x.bin
```

The `-o` option specifies the output directory (the current directory in this case). The `-pc` option specifies that a CRC header should be appended. The `-i` option specifies the input file. An output file called *lpc313x.rom* will be generated in the command line example above.

To create a boot image for USB DFU booting, the command is:

```
lpc313xImgCreator -o ./ -pd -i lpc313x.bin
```

The `-o` option specifies the output directory (the current directory in this case). The `-pd` option specifies that a file for USB boot mode should be generated. The `-i` option specifies the input file. An output file called *lpc313x.rom* will be generated in the command line example above.

The normal procedure is to add these commands to the makefile. This way no manual operations are needed to create the boot image.

5.3.2.2 EWARM from IAR

Under EWARM (IAR's IDE) it is easy to instruct the IDE to generate a binary file. Figure 27 below illustrates project settings for automatically generating a binary file named *lpc313x.bin* after each build.

Figure 28 further illustrates settings for automatically invoke the image creator application (*lpc313xImgCreator*). A CRC attached rom-file will be created. The post build command will be executed after the application has been built. The `-pc` command line option can be changed to `-pd` if USB DFU booting method is used.

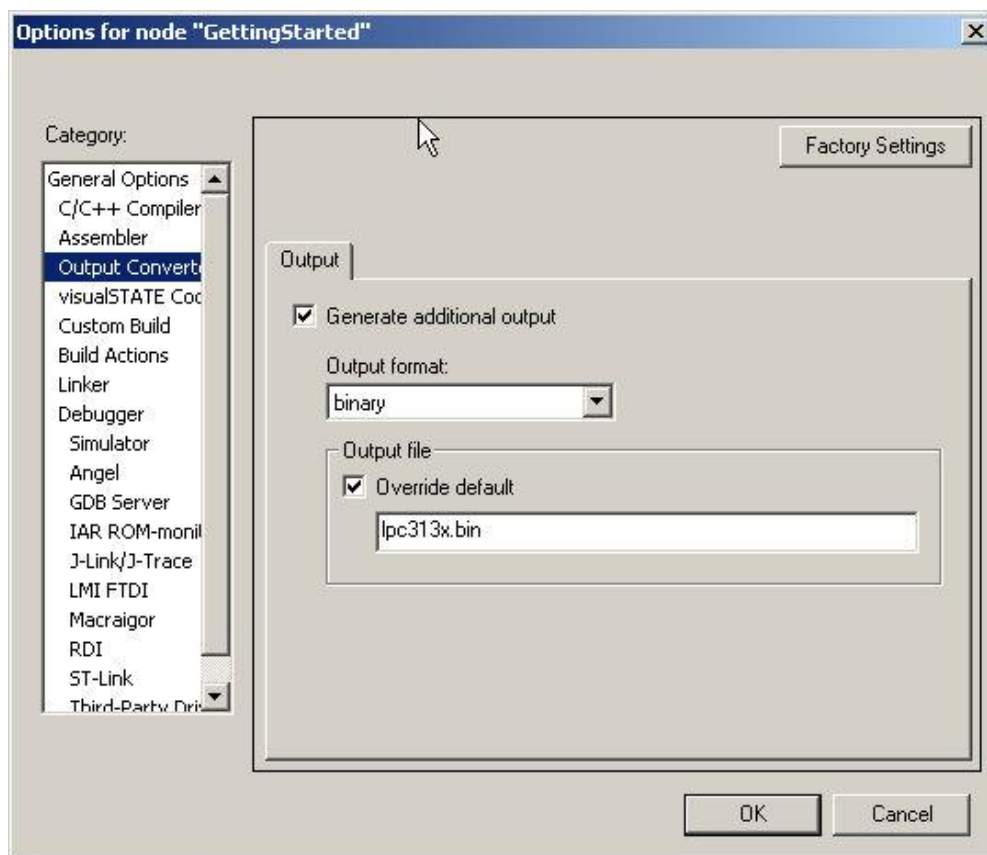


Figure 27 – EWARM Options for Output Converter

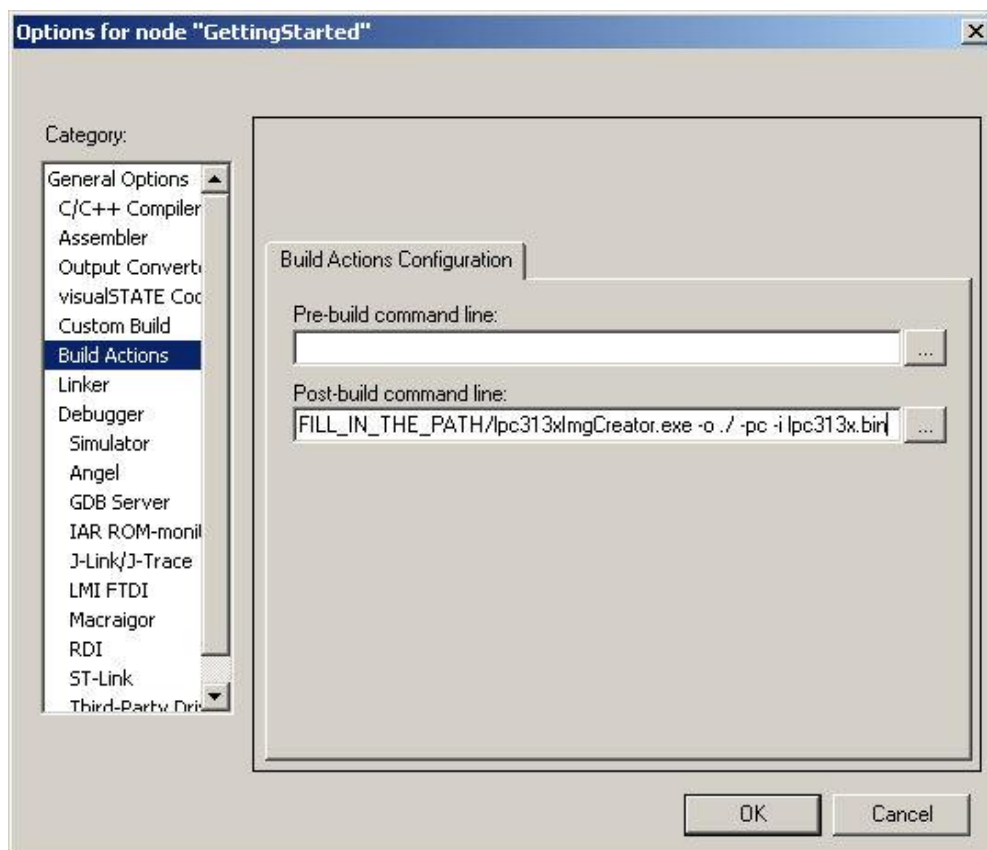


Figure 28 – EWARM Options for Build Actions

5.3.2.3 uVision from Keil

Under uVision (Keil's IDE), the command to create a binary file, named *lpc313x.bin* is as shown below. The input file is in this case typically the output file with axf-ending.

```
fromelf.exe -output lpc313x.bin -bin <input-file>
```

It is possible to automatically create the boot image when compiling/building. The example below illustrates how to configure a project in uVision (the Keil IDE). In the *Options for Target* window, select the *User* tab. Then configure the *Run #1* and *Run #2* options according to the picture below. These commands lines are run after the application is built. *Run #1* creates a binary file named *lpc313x.bin*. *Run #2* creates a CRC attached rom-file. The *-pc* command line option can be changed to *-pd* if USB DFU booting method is used.

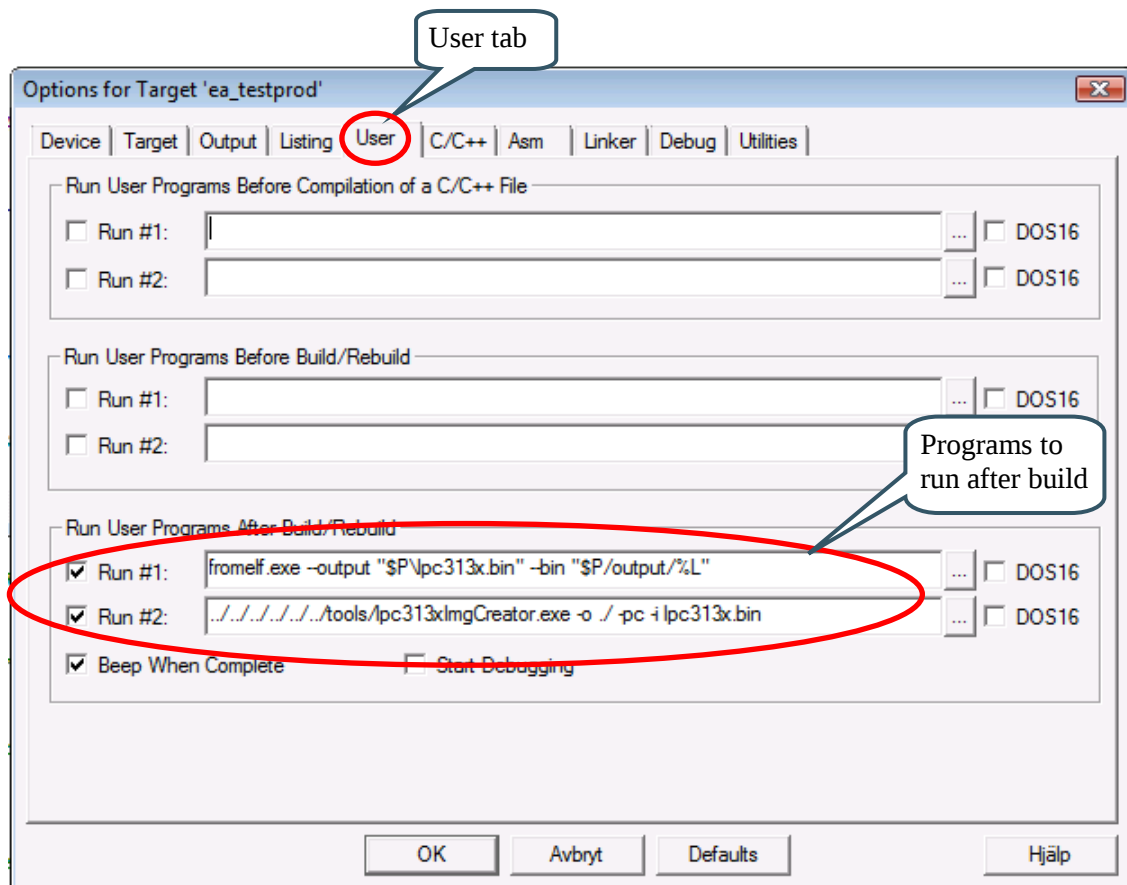


Figure 29 – uVision Options for Target

5.3.3 Booting via UART

When booting via UART, a terminal program (on a PC) that can send binary images must be connected to the LPC3131/41 UART channel. The USB-to-serial bridge can be used to connect to the LPC3131/41 UART channel. Alternatively the RS232 interface can be used directly. Make sure the jumpers on the *LPC31xx Base Board* are correctly set for the interface option selected. Terminal setting is: 115.2kbps, 8N1.

The boot code will output the following string over the UART channel:

```
LPC31xx READY FOR PLAIN IMAGE>
```

The download of the binary file should start within 2 minutes from this message. When the boot image is downloaded the following string will be sent from the boot code:

```
Download finished
```

Execution of the downloaded boot image will begin immediately after this. The picture below illustrates how it typically looks in the terminal program.

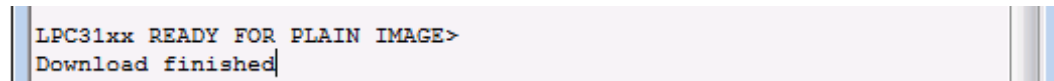


Figure 30 – Terminal Output for UART Boot

Note that the boot image must be 128kByte, or less, for LPC3131/41.

5.3.4 Booting via SPI NOR flash

When booting via SPI the boot image is downloaded from the SPI NOR flash into LPC3131/41 internal RAM immediately after reset. Execution is also started immediately after download. No message is sent to the UART channel.

Downloading a boot image into the SPI NOR flash is a two step process, as explained below:

1. First set the system to UART boot, and download a 'SPI NOR flash program' program. This is done via normal UART booting, just like described in the previous section.
The 'SPI NOR flash program' is one of the sample applications found in the CDL package from NXP.
2. The 'SPI NOR flash program' will output the following string over the UART channel:

```
SPI programmer is ready for download>
```

Now, download the actual boot image to be used for SPI booting. The download process should start within 2 minutes after this message has appeared. When the boot image is downloaded the following string will be sent from the 'SPI NOR flash program':

```
Download finished
Programing flash
##### <multiple hashes> #####
Verifying flash
##### <multiple hashes> #####
Done!!!
```

Execution of the downloaded boot image will begin immediately after this. The picture below illustrates how it typically looks in the terminal program. The two download phases are marked in the picture.

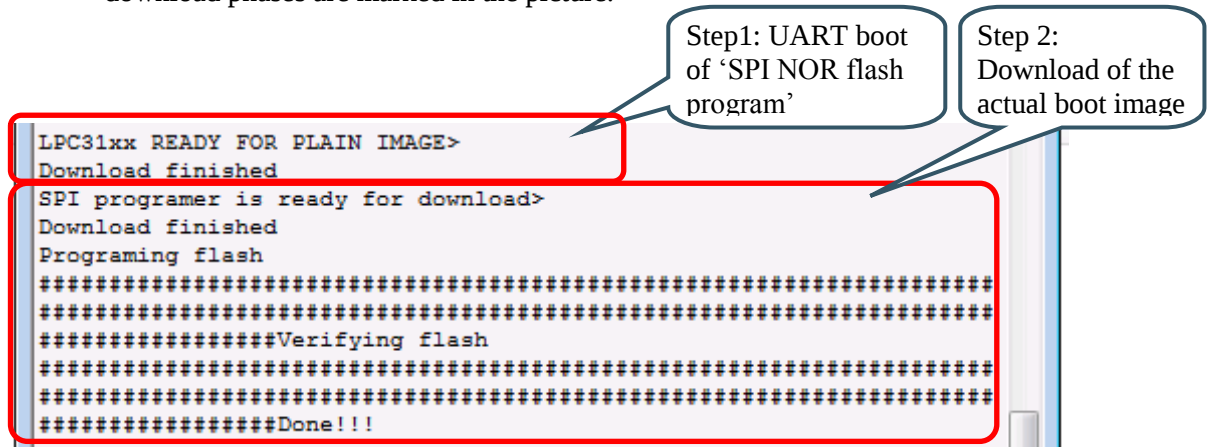


Figure 31 – Terminal Output for SPI Boot

Note that the SPI boot image must be 128kByte, or less, for LPC3131/41.

5.3.5 Booting via USB DFU class

When booting via USB, a special (PC) program must be used to connect to the DFU device that the boot code implements in the LPC3131/41. Follow the list below to download a boot image.

1. Connect a USB cable (mini-B to A) from your computer to the LPC31xx Base Board. Note that it is the LPC3131/41 USB connection that should be connected to, not the UART-to-serial bridge on the *LPC31xx Base Board*. See Figure 33 for an illustration where the correct USB connector can be found.
2. Install DFU drivers (available on the Embedded Artists support site).
3. Start the DFU application (DFUAPP.exe). The connected LPC3131/41 can be seen in the list of devices.
4. Select a file to download (named *_usb.rom in the pre-compiled applications available on the Embedded Artists support site).
5. Warning about the file not containing a suffix can sometimes be generated. Just ignore such messages and click 'Yes' to continue.
6. Select Start Download.

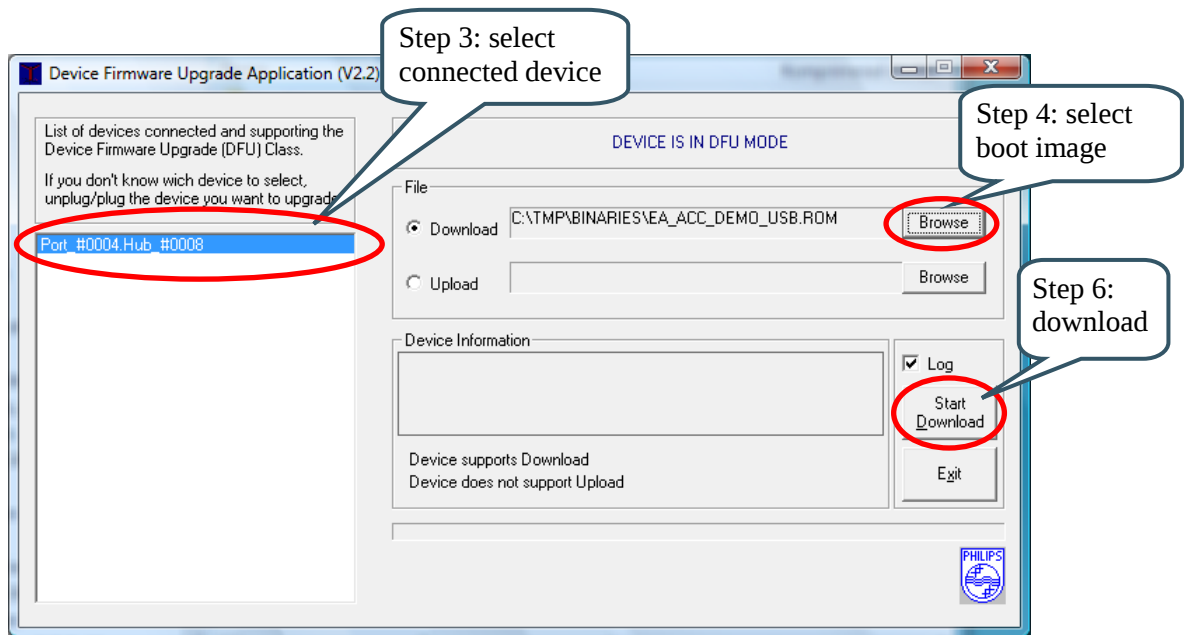


Figure 32 – Device Firmware Upgrade Application Screenshot

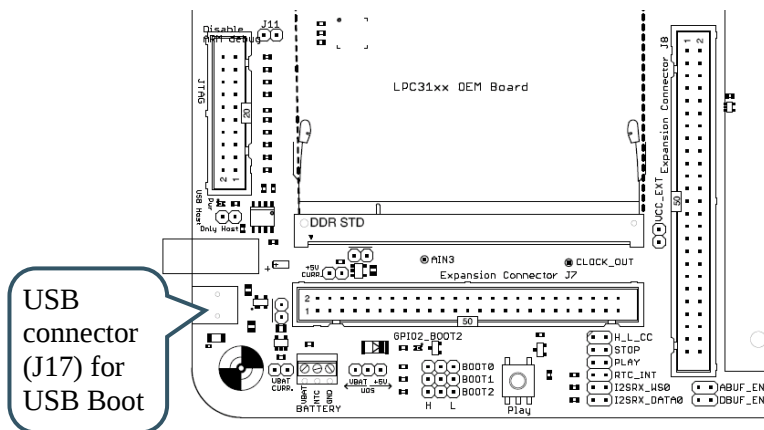


Figure 33 – LPC31xx Base Board USB Connector to LPC3131/41

5.3.6 LED on GPIO2

The boot code will signal any error during boot process by toggling GPIO2 pin. There is a LED connected to this pin for direct visual feedback. The picture below illustrates the position of the LED in relation to the boot jumpers.

Typical errors could be that booting has timed out (must be done within 2 minutes after reset), wrong boot image format or CRC error detected in the downloaded boot image.

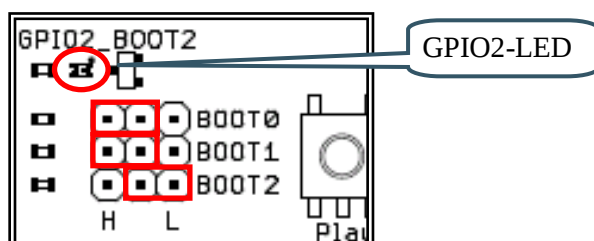


Figure 34 – GPIO2-LED Position

6 Further Information

The LPC3131/41 microcontroller is a complex circuit and there are a number of other documents with more information. The following documents are recommended as a complement to this document.

- [1] NXP LPC3131 Datasheet
<http://ics.nxp.com/products/lpc3000/datasheet/lpc3130.lpc3131.pdf>
- [2] NXP LPC3141 Datasheet
<http://ics.nxp.com/products/lpc3000/datasheet/lpc3141.lpc3143.pdf>
- [3] NXP LPC3131 User's Manual
<http://ics.nxp.com/support/documents/microcontrollers/pdf/user.manual.lpc3130.lpc3131.pdf>
- [4] NXP LPC3141 User's Manual
<http://ics.nxp.com/support/documents/microcontrollers/pdf/user.manual.lpc314x.pdf>
- [5] ARM926EJ-S Technical Reference Manual. Document identity: DDI0198E
http://infocenter.arm.com/help/topic/com.arm.doc.ddi0198e/DDI0198E_arm926ejs_r0p5_trm.pdf
- [6] ARM Architecture Reference Manual. Document identity: DDI0100E
Book, Second Edition, edited by David Seal, Addison-Wesley: ISBN 0-201-73719-1
Also available in PDF form on the ARM Technical Publications CD
- [7] ARM System Developer's Guide – Designing and Optimizing System Software, by A.N. Sloss, D Symes, C. Wright. Elsevier: ISBN 1-55860-874-5
- [8] ARM9 vs ARM7 core comparison
This document from ARM gives a good overview of the ARM9 core, compared to the ARM7 core that for example is found in the LPC2xxx family.
<http://www.arm.com/pdfs/comparison-arm7-arm9-v1.pdf>
- [9] Embedded System Design on a Shoestring, by Lewin Edwards.
Newnes: ISBN 0750676094.
- [10] GNU Manuals
<http://www.gnu.org/manual/>
- [11] GNU ARM tool chain for Cygwin
<http://www.gnuarm.com>
- [12] An Introduction to the GNU Compiler and Linker, by Bill Gatliff
<http://www.billgatliff.com>
- [13] LPC3000 Yahoo Group. A discussion forum dedicated entirely to the NXP LPC3xxx series of microcontrollers.
<http://groups.yahoo.com/group/lpc3000/>
- [14] LPC2000 Yahoo Group. A discussion forum dedicated entirely to the NXP LPC2xxx series of microcontrollers.
<http://groups.yahoo.com/group/lpc2000/>

Note that there can be newer versions of the documents than the ones linked to here. Always check for the latest information / version.